



**10-FY07HVA075S502-L985F18**  
**10-PY07HVA075S502-L985F18Y**  
datasheet

Vincotech

<b>flowPACK 1 H6.5</b>		<b>650 V / 75 A</b>
<b>Features</b>		
<ul style="list-style-type: none"><li>• Innovative H6.5 topology</li><li>• Fast IGBT S5</li><li>• Optimized for wide range of load conditions</li><li>• LVRT (Low voltage ride through) capability</li><li>• Integrated temperature sensor</li></ul>		
<b>Target applications</b>		
<ul style="list-style-type: none"><li>• Solar Inverters</li><li>• Special Application</li></ul>		
<b>Types</b>		<b>Schematic</b> 
<ul style="list-style-type: none"><li>• 10-FY07HVA075S502-L985F18</li><li>• 10-PY07HVA075S502-L985F18Y</li></ul>		

## Maximum Ratings

$T_j = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
<b>Low Buck Switch / High Buck Switch</b>				
Collector-emitter voltage	$V_{CES}$		650	V
Collector current	$I_C$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	58	A
Repetitive peak collector current	$I_{CRM}$	$t_p$ limited by $T_{jmax}$	225	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	86	W
Gate-emitter voltage	$V_{GES}$		$\pm 20$	V
Maximum junction temperature	$T_{jmax}$		175	$^\circ\text{C}$



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## Maximum Ratings

$T_j = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
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### Buck Diode

Peak repetitive reverse voltage	$V_{RRM}$		650	V
Continuous (direct) forward current	$I_F$	$T_j = T_{jmax}$	47	A
Repetitive peak forward current	$I_{FRM}$		100	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$	63	W
Maximum junction temperature	$T_{jmax}$		175	$^\circ\text{C}$

### Boost Switch

Collector-emitter voltage	$V_{CES}$		650	V
Collector current	$I_C$	$T_j = T_{jmax}$	58	A
Repetitive peak collector current	$I_{CRM}$	$t_p$ limited by $T_{jmax}$	225	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$	86	W
Gate-emitter voltage	$V_{GES}$		$\pm 20$	V
Maximum junction temperature	$T_{jmax}$		175	$^\circ\text{C}$

### Low Boost Diode / High Boost Diode

Peak repetitive reverse voltage	$V_{RRM}$		650	V
Continuous (direct) forward current	$I_F$	$T_j = T_{jmax}$	47	A
Repetitive peak forward current	$I_{FRM}$		100	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$	63	W
Maximum junction temperature	$T_{jmax}$		175	$^\circ\text{C}$



## Maximum Ratings

$T_j = 25 \text{ } ^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
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### Module Properties

#### Thermal Properties

Storage temperature	$T_{stg}$		-40...+125	°C
Operation temperature under switching condition	$T_{jop}$		-40...(T <sub>jmax</sub> - 25)	°C

#### Isolation Properties

Isolation voltage	$V_{isol}$	DC Test Voltage*	$t_p = 2 \text{ s}$	6000	V	
		AC Voltage	$t_p = 1 \text{ min}$	2500	V	
Creepage distance				min. 12,7	mm	
Clearance		Solder pin version		7,85	mm	
Comparative Tracking Index		Press-fit pin version		8,3	mm	
Comparative Tracking Index				> 200		

\*100 % tested in production



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## Characteristic Values

Parameter	Symbol	Conditions						Value			Unit	
		$V_{GE}$ [V]	$V_{GS}$ [V]	$V_{CE}$ [V]	$V_{DS}$ [V]	$I_c$ [A]	$I_D$ [A]	$T_j$ [°C]	Min	Typ	Max	

### Low Buck Switch / High Buck Switch

#### Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{GE} = V_{CE}$			0,00075	25		3,2	4	4,8	V
Collector-emitter saturation voltage	$V_{CESat}$		15		75	125 150			1,56 1,56 1,59	1,75	V
Collector-emitter cut-off current	$I_{CES}$		0	650		25				50	µA
Gate-emitter leakage current	$I_{GES}$		20	0		25				100	nA
Internal gate resistance	$r_g$								none		Ω
Input capacitance	$C_{ies}$	$f = 1 \text{ Mhz}$	0	25	25	25			4500		pF
Output capacitance	$C_{oes}$										
Reverse transfer capacitance	$C_{res}$										
Gate charge	$Q_g$		15	520	75	25			164		nC

#### Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)							1,10		K/W
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#### Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 4 \Omega$ $R_{goff} = 4 \Omega$	-5 / 15	350	75	25		31			ns
Rise time	$t_r$					125		31			
Turn-off delay time	$t_{d(off)}$					150		31			
Fall time	$t_f$	$Q_{fFWD} = 2,2 \mu\text{C}$ $Q_{fFWD} = 4 \mu\text{C}$ $Q_{fFWD} = 4,7 \mu\text{C}$	-5 / 15	350	75	25		10			mWs
Turn-on energy (per pulse)	$E_{on}$					125		10			
Turn-off energy (per pulse)	$E_{off}$					150		110			
						25		126			
						125		132			
						150					
						25		25			
						125		32			
						150					
						25		0,450			
						125		0,701			
						150		0,758			
						25		0,457			
						125		0,875			
						150		1,02			



## Characteristic Values

Parameter	Symbol	Conditions						Value			Unit
			$V_{GE}$ [V]	$V_{CE}$ [V]	$I_c$ [A]	$I_D$ [A]	$T_1$ [°C]	Min	Typ	Max	
			$V_{GS}$ [V]	$V_{DS}$ [V]	$I_F$ [A]	$I_F$ [A]					

### Buck Diode

#### Static

Forward voltage	$V_F$				50	25 125 150		1,50 1,44 1,42	1,92		V
Reverse leakage current	$I_R$			650		25			2,65		µA

#### Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						1,50		K/W
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#### Dynamic

Peak recovery current	$I_{RRM}$	$di/dt = 5329 \text{ A/}\mu\text{s}$ $di/dt = 8023 \text{ A/}\mu\text{s}$ $di/dt = 7260 \text{ A/}\mu\text{s}$	-5 / 15	350	75	25 125 150		86 110 117		A
Reverse recovery time	$t_{rr}$					25 125 150		55 87 101		ns
Recovered charge	$Q_r$					25 125 150		2,18 4,04 4,70		µC
Reverse recovered energy	$E_{rec}$					25 125 150		0,381 0,838 1,02		mWs
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					25 125 150		5984 4040 4174		A/µs



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## Characteristic Values

Parameter	Symbol	Conditions						Value			Unit	
		$V_{GE}$ [V]	$V_{CE}$ [V]	$I_c$ [A]	$I_D$ [A]	$T_1$ [°C]	$V_{GS}$ [V]	$V_{DS}$ [V]	$I_F$ [A]	Min	Typ	Max

### Boost Switch

#### Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{GE} = V_{CE}$			0,00075	25		3,2	4	4,8	V
Collector-emitter saturation voltage	$V_{CESat}$		15		75	125 150			1,56 1,56 1,59	1,75	V
Collector-emitter cut-off current	$I_{CES}$		0	650		25				50	µA
Gate-emitter leakage current	$I_{GES}$		20	0		25				100	nA
Internal gate resistance	$r_g$								none		Ω
Input capacitance	$C_{ies}$	$f = 1 \text{ Mhz}$	0	25	25	25			4500		pF
Output capacitance	$C_{oes}$										
Reverse transfer capacitance	$C_{res}$										
Gate charge	$Q_g$		15	520	75	25			164		nC

#### Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)							1,10		K/W
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#### Dynamic (T21, D12)

Turn-on delay time	$t_{d(on)}$	$R_{goff} = 4 \Omega$ $R_{gon} = 4 \Omega$	$\pm 15$	350	76	25		60			ns			
Rise time	$t_r$					125		62						
						150		60						
						25		11						
						125		10						
						150		11						
Turn-off delay time	$t_{d(off)}$	$Q_{fFWD} = 2,2 \mu\text{C}$ $Q_{fFWD} = 4,1 \mu\text{C}$ $Q_{fFWD} = 4,7 \mu\text{C}$				25		88			mWs			
Fall time	$t_f$					125		106						
						150		109						
						25		12						
						125		17						
						150		22						
Turn-on energy (per pulse)	$E_{on}$	$Q_{fFWD} = 2,2 \mu\text{C}$ $Q_{fFWD} = 4,1 \mu\text{C}$ $Q_{fFWD} = 4,7 \mu\text{C}$				25		0,661						
						125		0,904						
						150		0,986						
Turn-off energy (per pulse)	$E_{off}$					25		0,604						
						125		1,04						
						150		1,11						



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## Characteristic Values

Parameter	Symbol	Conditions						Value			Unit
			$V_{GE}$ [V]	$V_{CE}$ [V]	$I_c$ [A]	$I_D$ [A]	$T_1$ [°C]	Min	Typ	Max	
			$V_{GS}$ [V]	$V_{DS}$ [V]	$I_F$ [A]	$I_F$ [A]					

### Low Boost Diode

#### Static

Forward voltage	$V_F$				50	25 125 150		1,50 1,44 1,42	1,92		V
Reverse leakage current	$I_R$			650		25			2,65		µA

#### Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						1,50		K/W
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#### Dynamic (T21, D12)

Peak recovery current	$I_{RRM}$	$di/dt = 6510 \text{ A/µs}$ $di/dt = 4900 \text{ A/µs}$ $di/dt = 6125 \text{ A/µs}$	$\pm 15$	350	76	25		83		A
Reverse recovery time	$t_{rr}$					125		93		
Recovered charge	$Q_r$					150		94		
Reverse recovered energy	$E_{rec}$					25		59		ns
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					125		100		



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## Characteristic Values

Parameter	Symbol	Conditions						Value			Unit
			$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V] $V_F$ [V]	$I_c$ [A] $I_D$ [A] $I_F$ [A]	$T_1$ [°C]	Min	Typ	Max		

### Boost Switch

#### Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{GE} = V_{CE}$			0,00075	25	3,2	4	4,8	V
Collector-emitter saturation voltage	$V_{CESat}$		15		75	125 150		1,56 1,56 1,59	1,75	V
Collector-emitter cut-off current	$I_{CES}$		0	650		25			50	µA
Gate-emitter leakage current	$I_{GES}$		20	0		25			100	nA
Internal gate resistance	$r_g$							none		Ω
Input capacitance	$C_{ies}$	$f = 1 \text{ Mhz}$	0	25	25	25	4500	130	17	pF
Output capacitance	$C_{oes}$									
Reverse transfer capacitance	$C_{res}$									
Gate charge	$Q_g$		15	520	75	25		164		nC

#### Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						1,10		K/W
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#### Dynamic (T21, D20)

Turn-on delay time	$t_{d(on)}$	$R_{goff} = 4 \Omega$ $R_{gon} = 4 \Omega$	$\pm 15$	350	76	25		65		ns
Rise time	$t_r$					125		64		
Turn-off delay time	$t_{d(off)}$					150		66		
Fall time	$t_f$	$Q_{fFWD} = 2,1 \mu\text{C}$ $Q_{fFWD} = 4 \mu\text{C}$ $Q_{fFWD} = 4,5 \mu\text{C}$	$\pm 15$	350	76	25		12		mWs
Turn-on energy (per pulse)	$E_{on}$					125		11		
Turn-off energy (per pulse)	$E_{off}$					150		13		
						25		87		
						125		105		
						150		110		
						25		14		
						125		21		
						150		31		
						25		0,527		
						125		0,873		
						150		0,855		
						25		0,733		
						125		1,04		
						150		1,29		



## Characteristic Values

Parameter	Symbol	Conditions						Value			Unit
			$V_{GE}$ [V]	$V_{CE}$ [V]	$I_c$ [A]	$I_D$ [A]	$T_1$ [°C]	Min	Typ	Max	
			$V_{GS}$ [V]	$V_{DS}$ [V]	$I_F$ [A]	$I_F$ [A]					

### High Boost Diode

#### Static

Forward voltage	$V_F$				50	25 125 150		1,50 1,44 1,42	1,92		V
Reverse leakage current	$I_R$			650		25			2,65		µA

#### Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						1,50		K/W
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#### Dynamic (T21, D20)

Peak recovery current	$I_{RRM}$	$di/dt = 6622 \text{ A/µs}$ $di/dt = 6272 \text{ A/µs}$ $di/dt = 6687 \text{ A/µs}$	$\pm 15$	350	76	25		71		A
Reverse recovery time	$t_{rr}$					125		92		
Recovered charge	$Q_r$					150		92		
Reverse recovered energy	$E_{rec}$					25		57		ns
Peak rate of fall of recovery current	$(di_r/dt)_{max}$					125		105		

### Thermistor

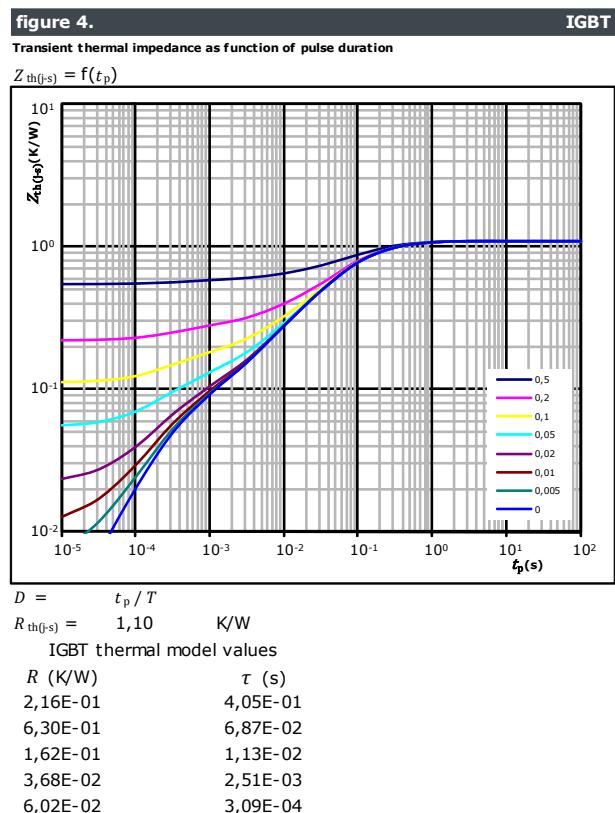
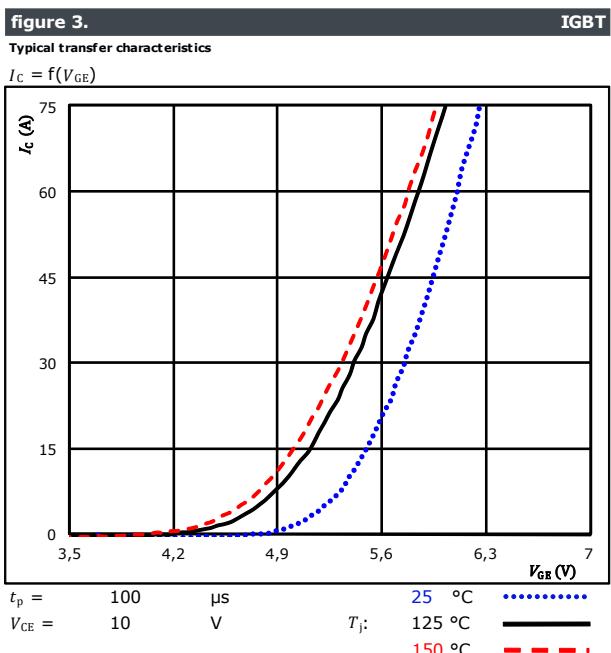
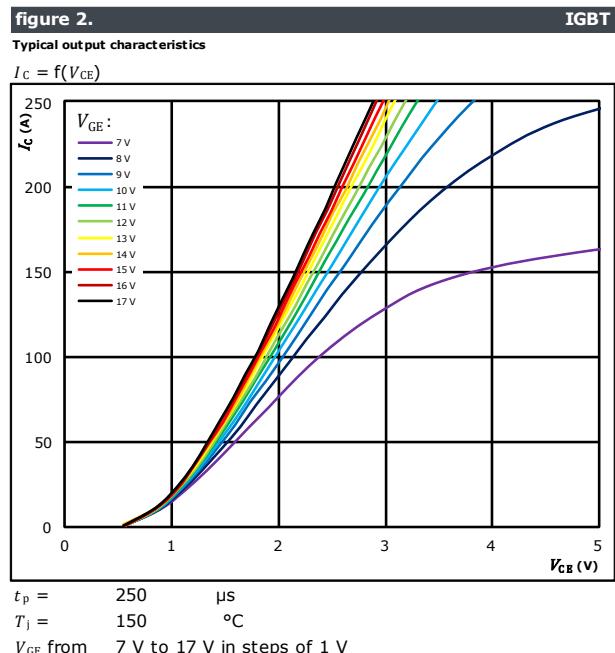
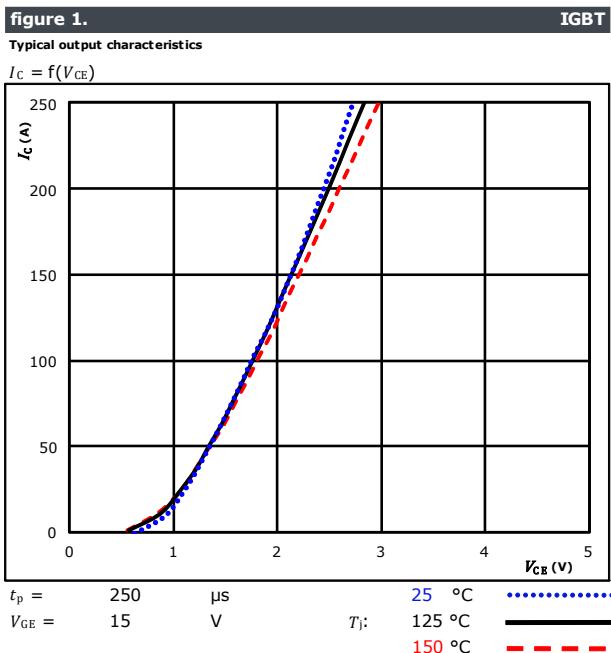
Rated resistance	$R$					25		22		kΩ
Deviation of $R_{100}$	$\Delta_{R/R}$	$R_{100} = 1484 \Omega$				100	-5	5	%	
Power dissipation	$P$					25		5		mW
Power dissipation constant						25		1,5		mW/K
B-value	$B_{(25/50)}$	Tol. ±1 %				25		3962		K
B-value	$B_{(25/100)}$	Tol. ±1 %				25		4000		K
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## Low Buck Switch / High Buck Switch Characteristics





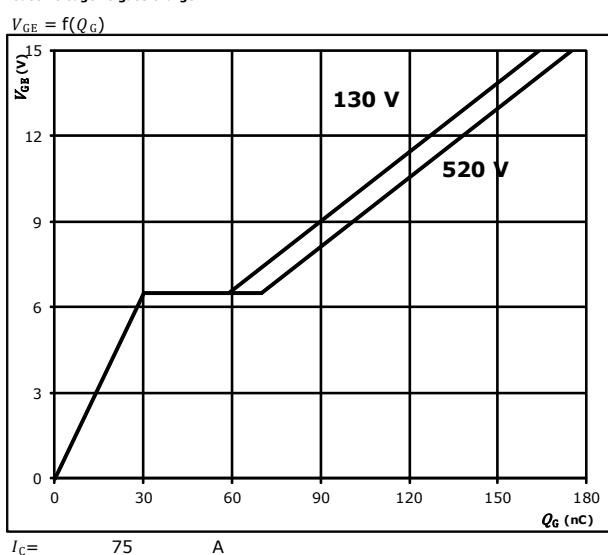
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10-PY07HVA075S502-L985F18Y**  
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## Low Buck Switch / High Buck Switch Characteristics

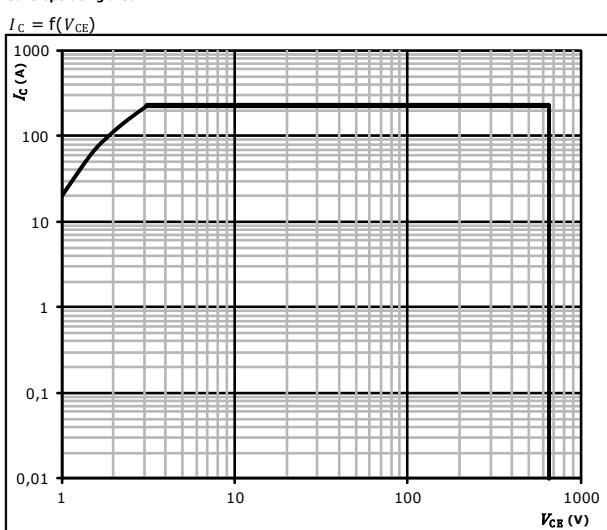
**figure 5.**

Gate voltage vs gate charge



**figure 6.**

Safe operating area



D = single pulse

T<sub>s</sub> = 80 °C

V<sub>GE</sub> = ±15 V

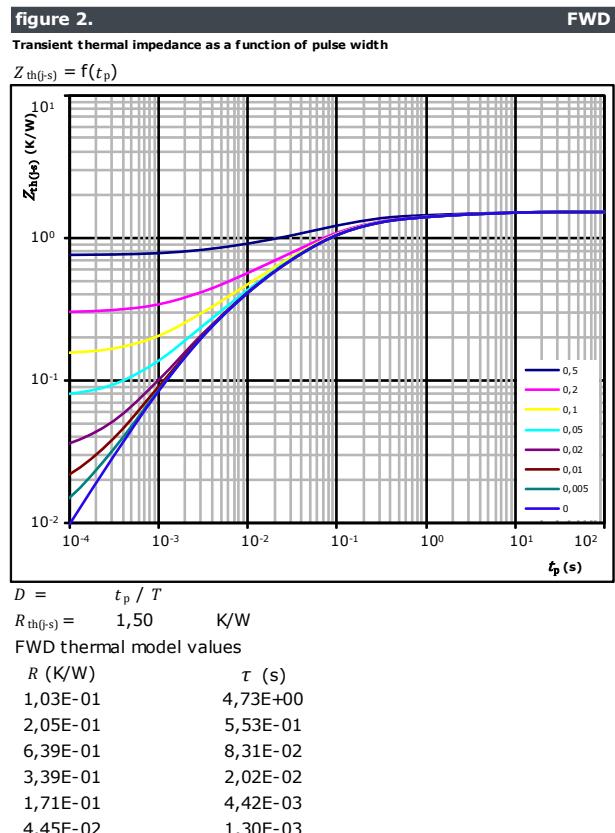
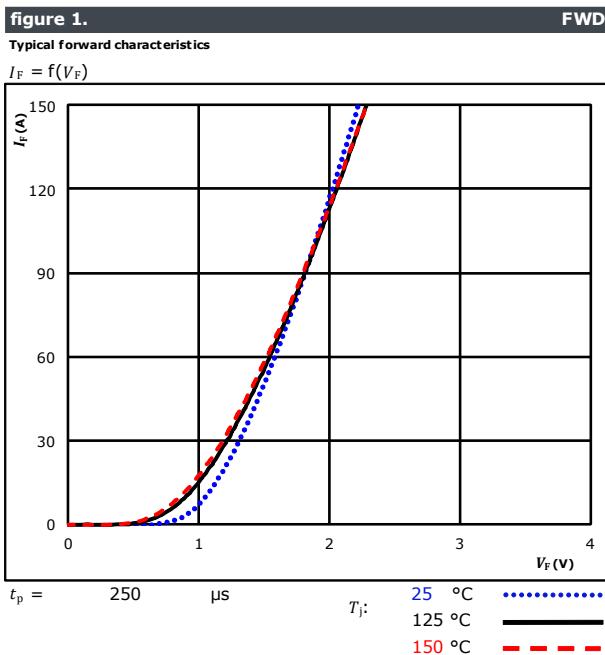
T<sub>j</sub> = T<sub>jmax</sub>



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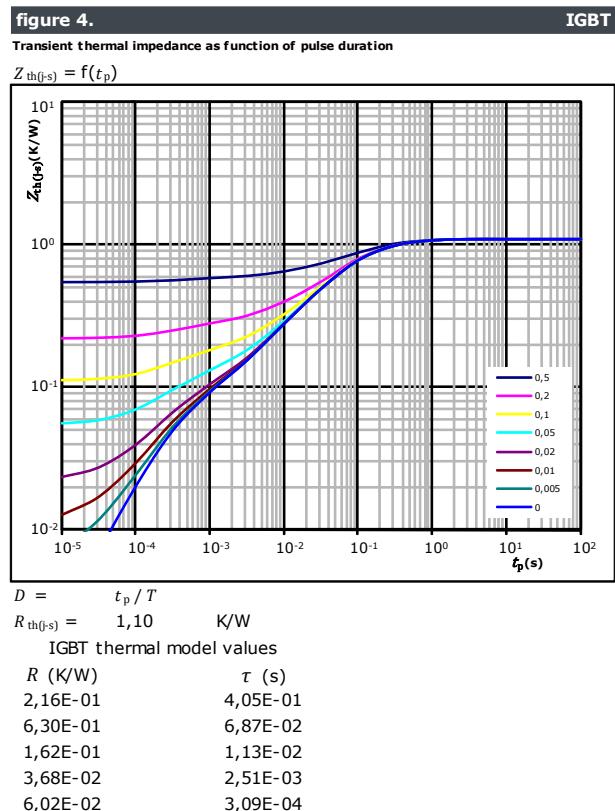
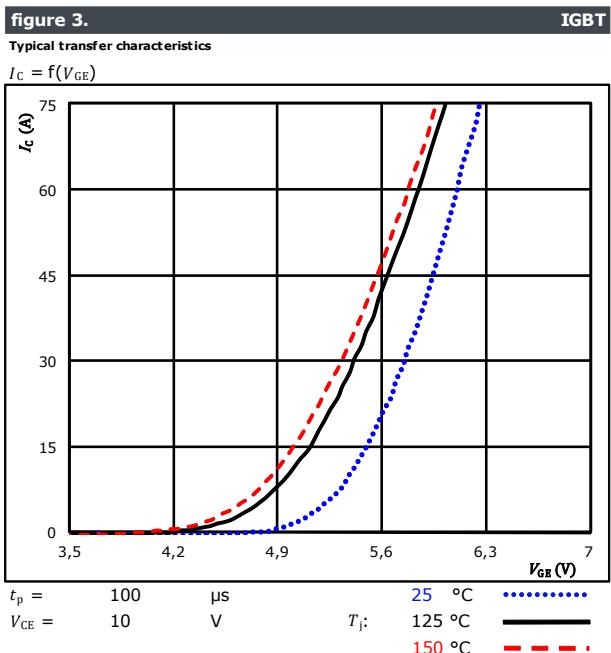
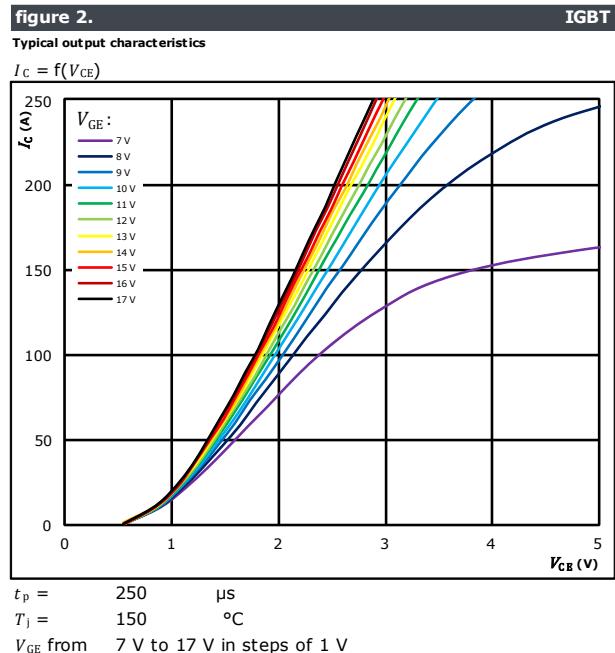
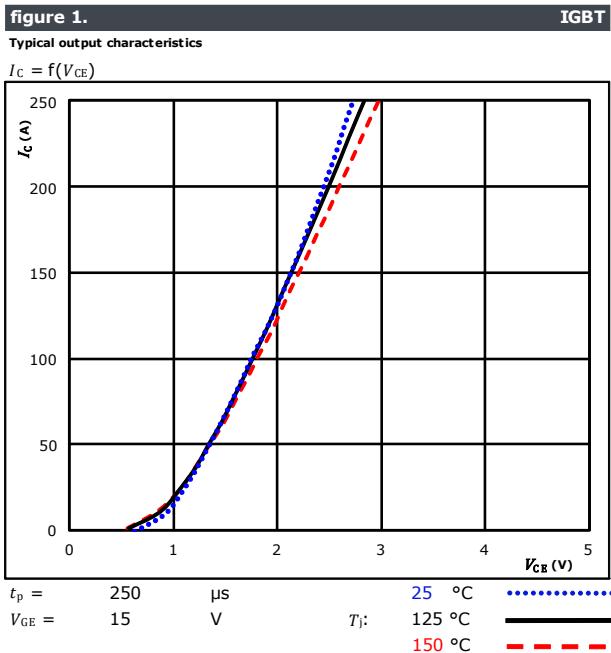
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## Buck Diode Characteristics





## Boost Switch Characteristics

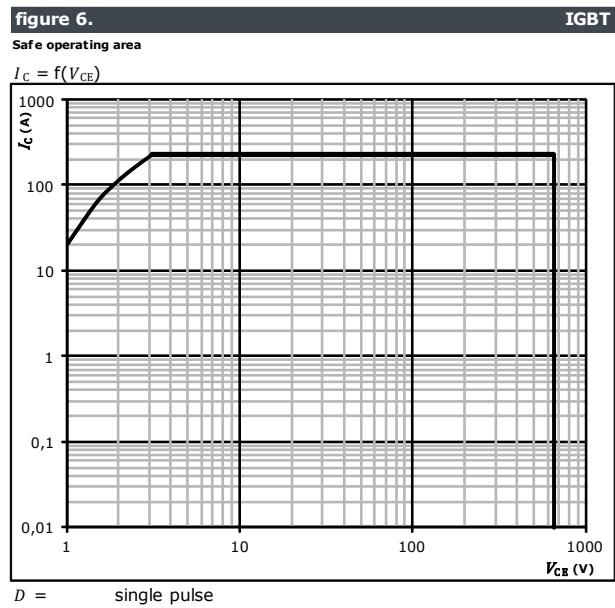
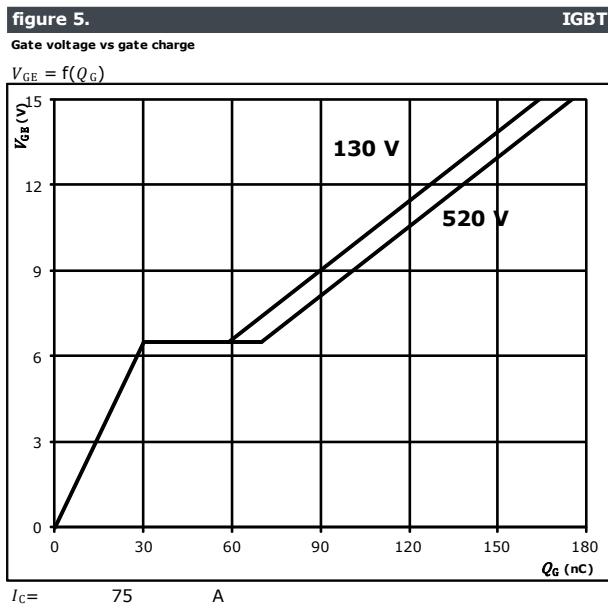




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## Boost Switch Characteristics





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## Low Boost Diode Characteristics

figure 1.

FWD

Typical forward characteristics

$$I_F = f(V_F)$$

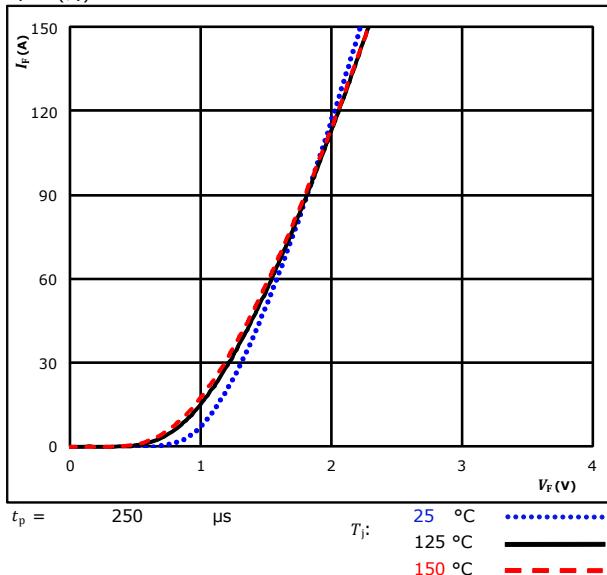
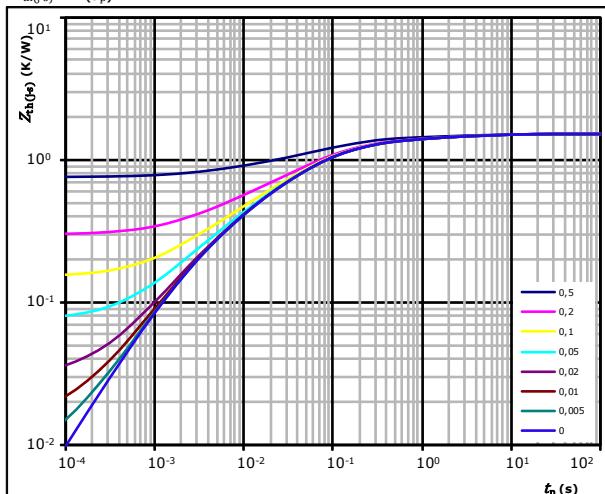


figure 2.

FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$$D = t_p / T$$

$$R_{th(j-s)} = 1,50 \text{ K/W}$$

FWD thermal model values

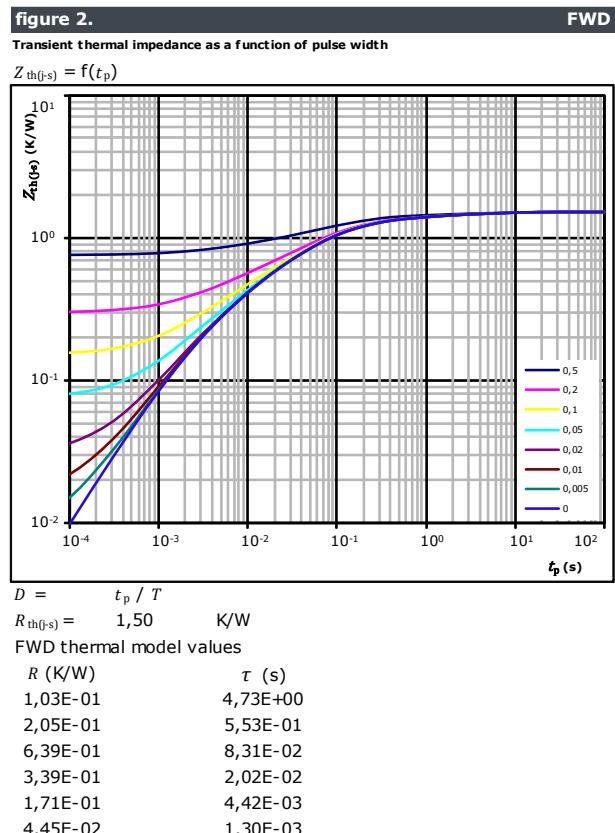
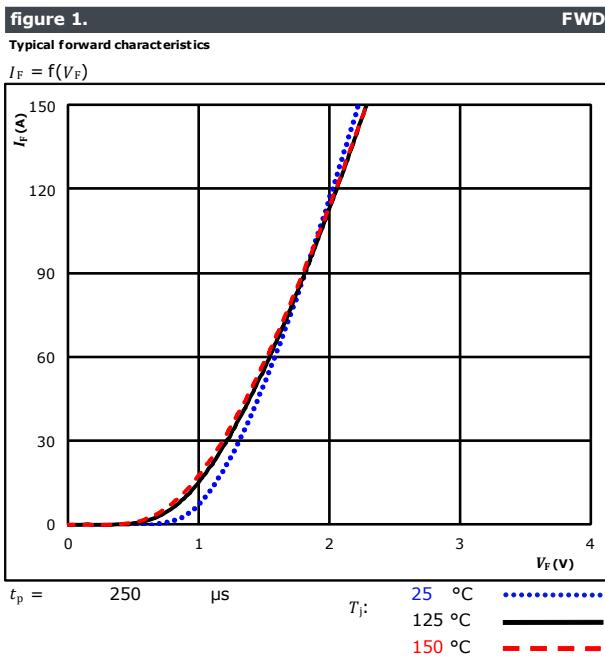
$R$ (K/W)	$\tau$ (s)
1,03E-01	4,73E+00
2,05E-01	5,53E-01
6,39E-01	8,31E-02
3,39E-01	2,02E-02
1,71E-01	4,42E-03
4,45E-02	1,30E-03



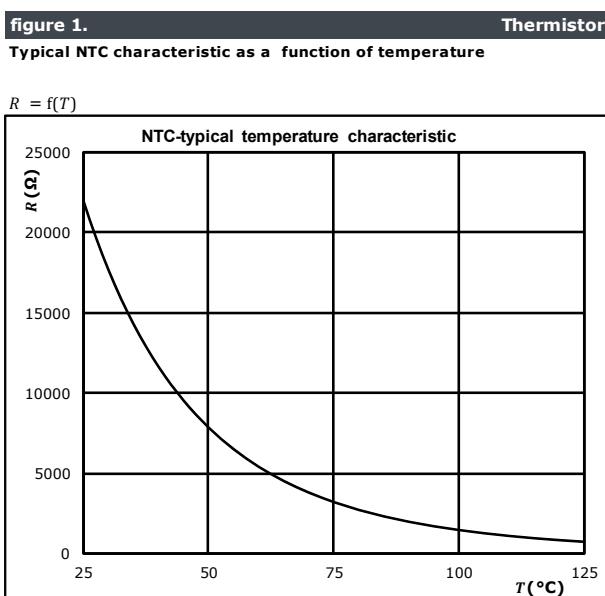
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## High Boost Diode Characteristics



## Thermistor Characteristics



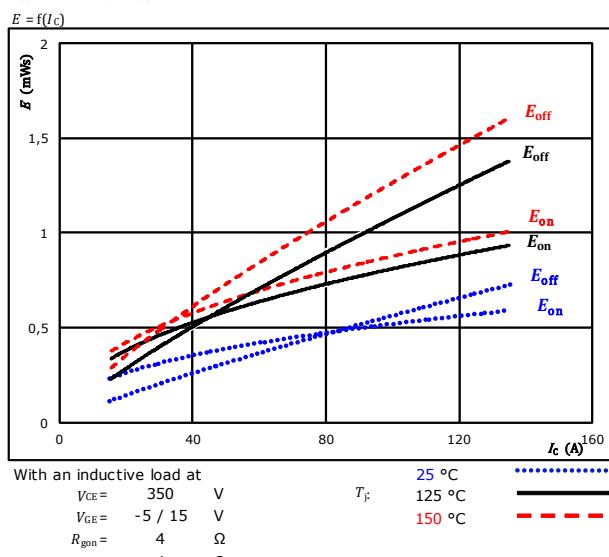


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## Low Buck / High Buck Switching Characteristics

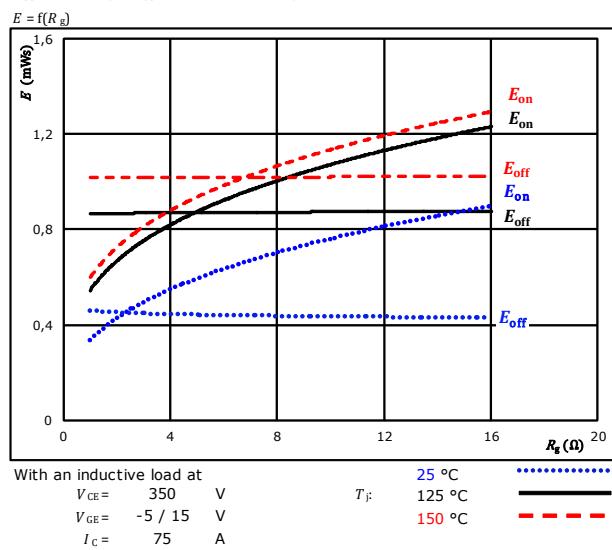
**figure 1.**

Typical switching energy losses as a function of collector current



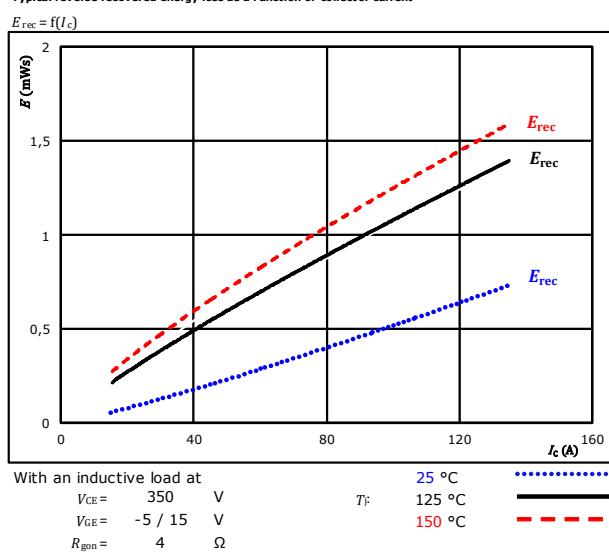
**figure 2.**

Typical switching energy losses as a function of gate resistor



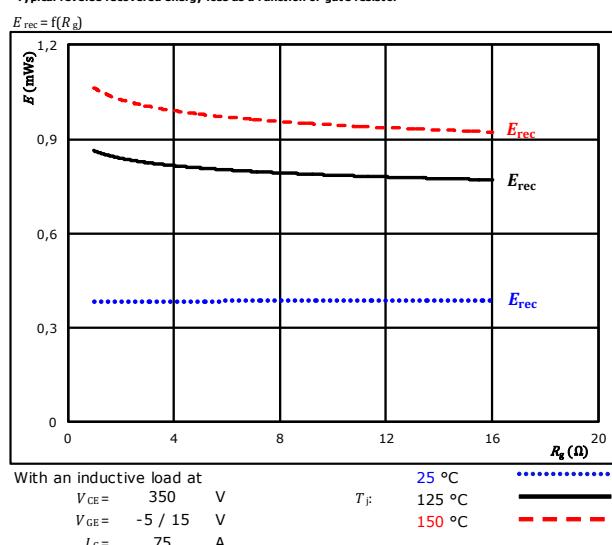
**figure 3.**

Typical reverse recovered energy loss as a function of collector current



**figure 4.**

Typical reverse recovered energy loss as a function of gate resistor



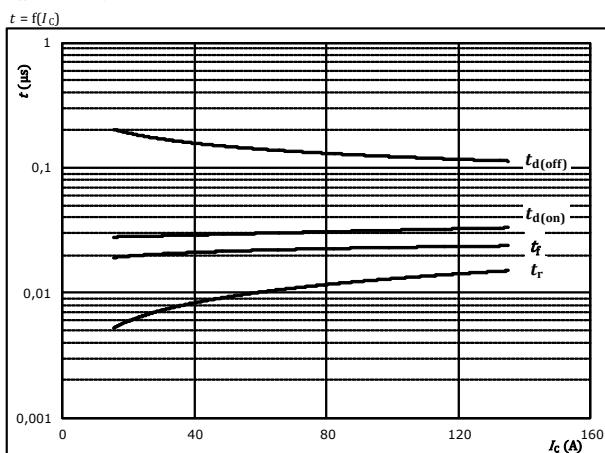


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## Low Buck / High Buck Switching Characteristics

**figure 5.**

Typical switching times as a function of collector current

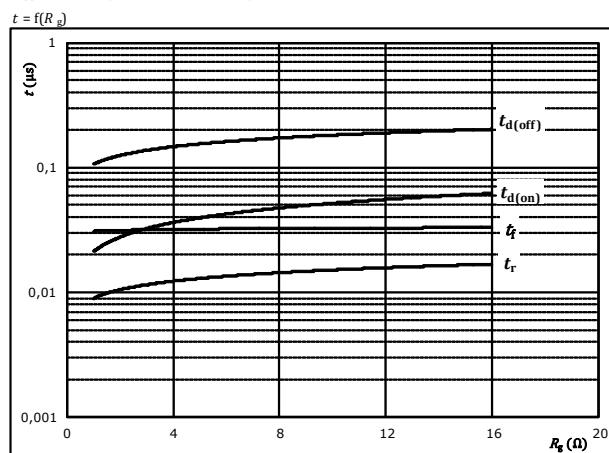


With an inductive load at

$T_J = 150^\circ\text{C}$   
 $V_{CE} = 350\text{ V}$   
 $V_{GE} = -5 / 15\text{ V}$   
 $R_{gon} = 4\Omega$   
 $R_{goff} = 4\Omega$

**figure 6.**

Typical switching times as a function of gate resistor

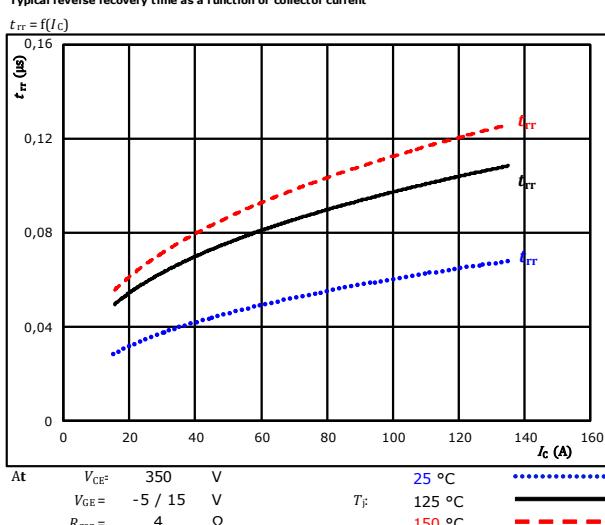


With an inductive load at

$T_J = 150^\circ\text{C}$   
 $V_{CE} = 350\text{ V}$   
 $V_{GE} = -5 / 15\text{ V}$   
 $I_c = 75\text{ A}$

**figure 7.**

Typical reverse recovery time as a function of collector current



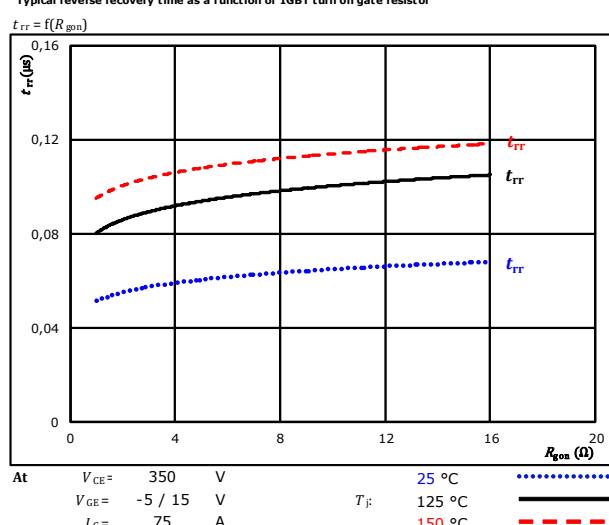
At

$V_{CE} = 350\text{ V}$   
 $V_{GE} = -5 / 15\text{ V}$   
 $R_{gon} = 4\Omega$

$T_J = 25^\circ\text{C}$   
 $T_f = 125^\circ\text{C}$   
 $150^\circ\text{C}$

**figure 8.**

Typical reverse recovery time as a function of IGBT turn on gate resistor



At

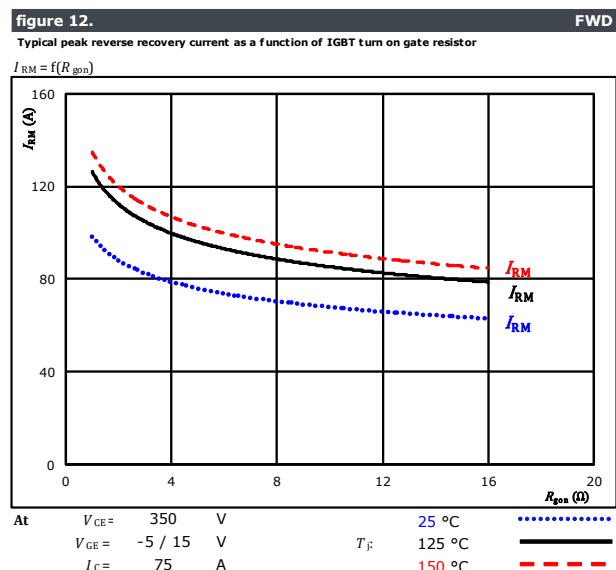
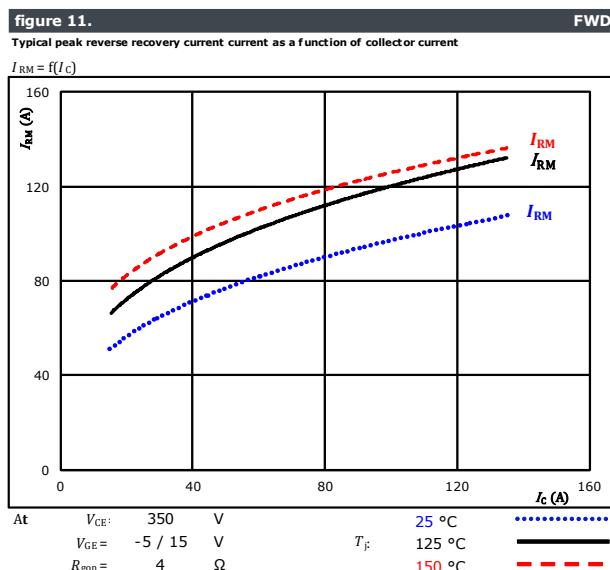
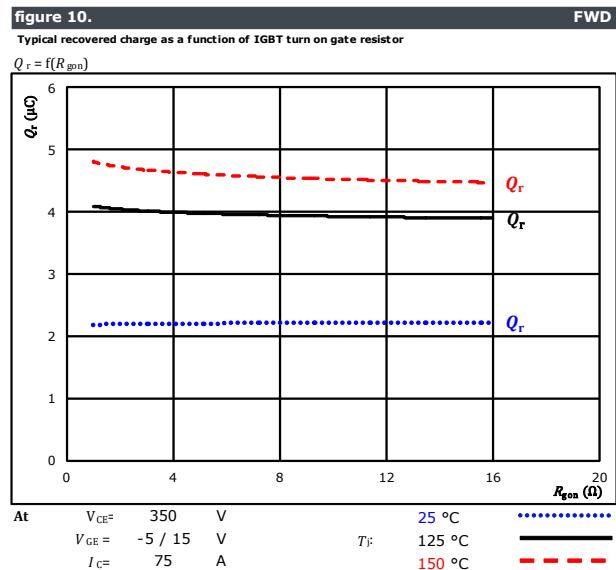
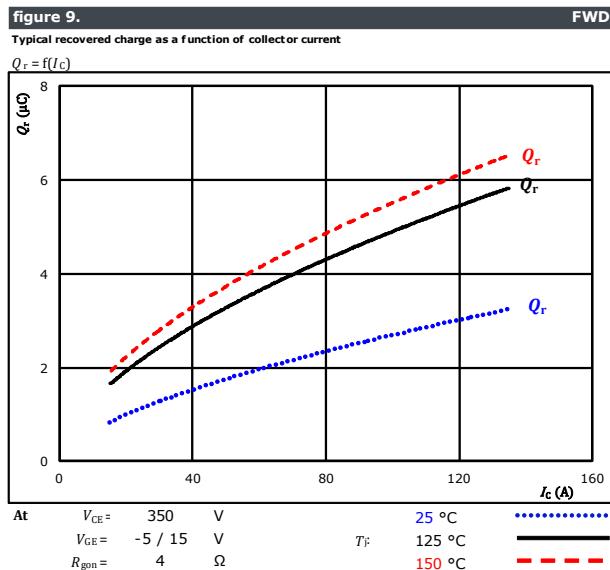
$V_{CE} = 350\text{ V}$   
 $V_{GE} = -5 / 15\text{ V}$   
 $I_c = 75\text{ A}$

$T_J = 25^\circ\text{C}$   
 $T_f = 125^\circ\text{C}$   
 $150^\circ\text{C}$



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## Low Buck / High Buck Switching Characteristics





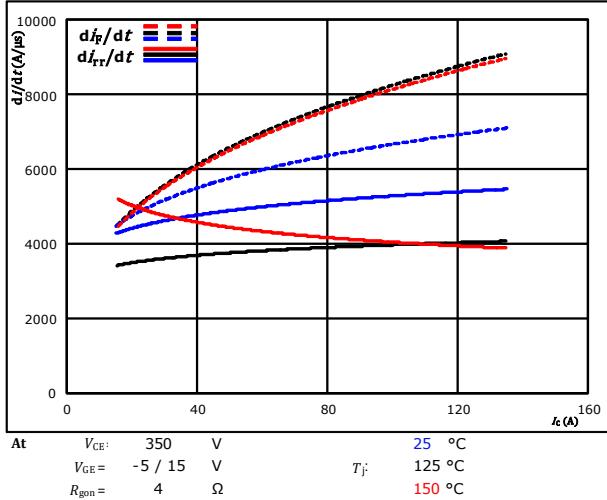
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## Low Buck / High Buck Switching Characteristics

**figure 13.**

Typical rate of fall of forward and reverse recovery current as a function of collector current

$di_F/dt, di_{rr}/dt = f(I_C)$

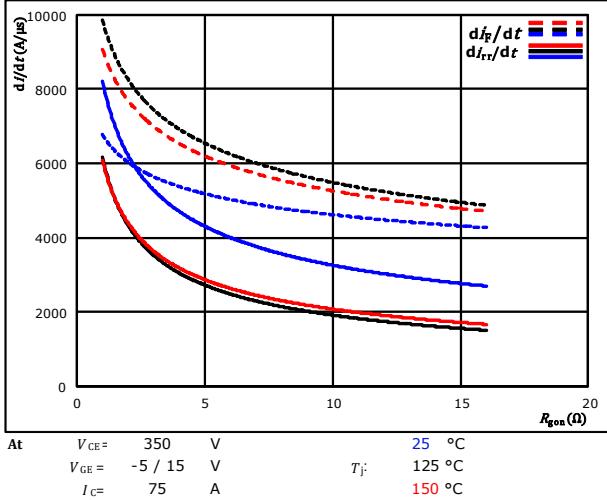


**FWD**

**figure 14.**

Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor

$di_F/dt, di_{rr}/dt = f(R_{gon})$



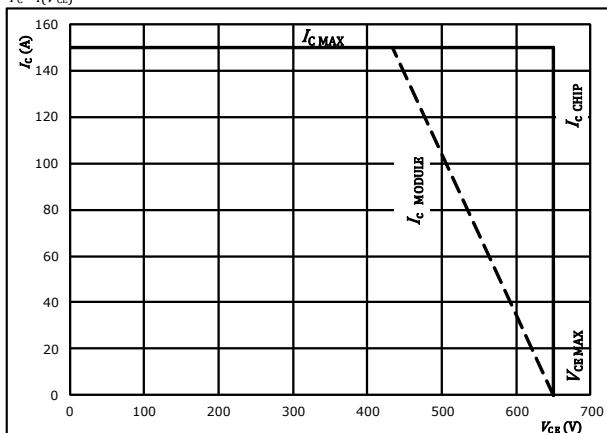
**FWD**

**figure 15.**

**IGBT**

Reverse bias safe operating area

$I_C = f(V_{CE})$





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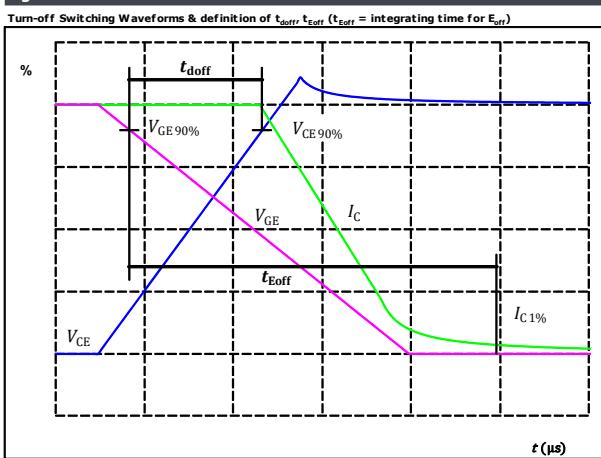
## Low Buck / High Buck Switching Definitions

### General conditions

$T_j$	=	125 °C
$R_{gon}$	=	4 Ω
$R_{goff}$	=	4 Ω

figure 1.

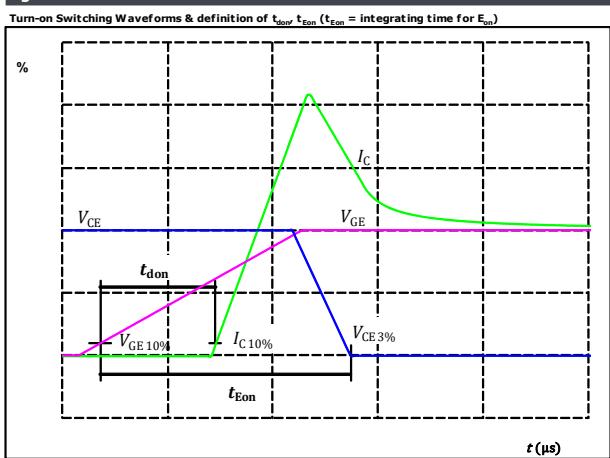
IGBT



$V_{GE}(0\%) = -5$  V  
 $V_{GE}(100\%) = 15$  V  
 $V_C(100\%) = 350$  V  
 $I_C(100\%) = 75$  A  
 $t_{doff} = 126$  ns

figure 2.

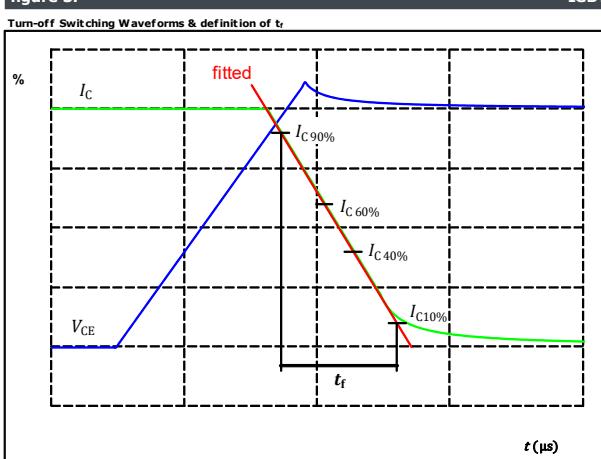
IGBT



$V_{GE}(0\%) = -5$  V  
 $V_{GE}(100\%) = 15$  V  
 $V_C(100\%) = 350$  V  
 $I_C(100\%) = 75$  A  
 $t_{don} = 31$  ns

figure 3.

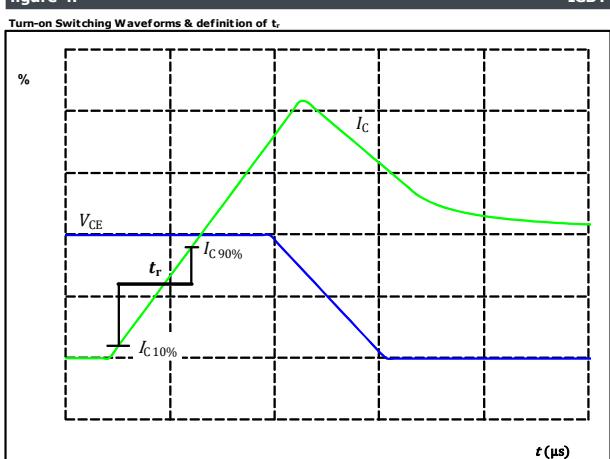
IGBT



$V_C(100\%) = 350$  V  
 $I_C(100\%) = 75$  A  
 $t_f = 25$  ns

figure 4.

IGBT



$V_C(100\%) = 350$  V  
 $I_C(100\%) = 75$  A  
 $t_r = 10$  ns



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datasheet

## Low Buck / High Buck Switching Characteristics

figure 5.

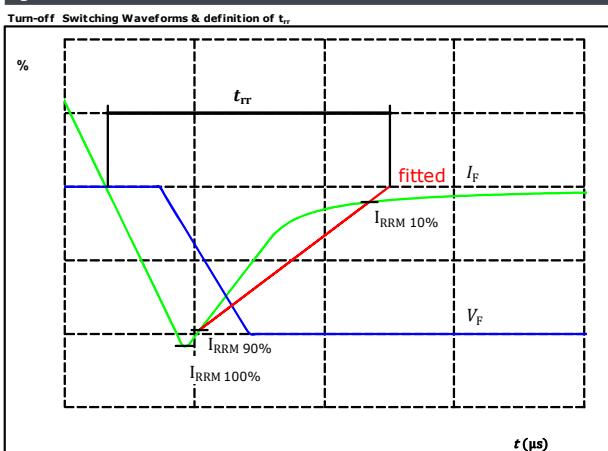
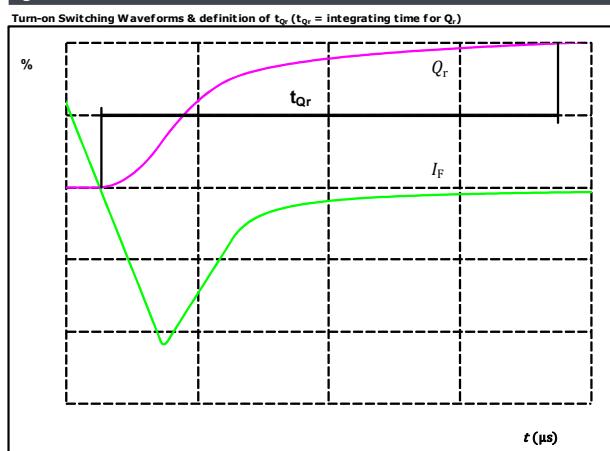


figure 6.





## Low Boost Switching Characteristics

figure 1.

Typical switching energy losses as a function of collector current

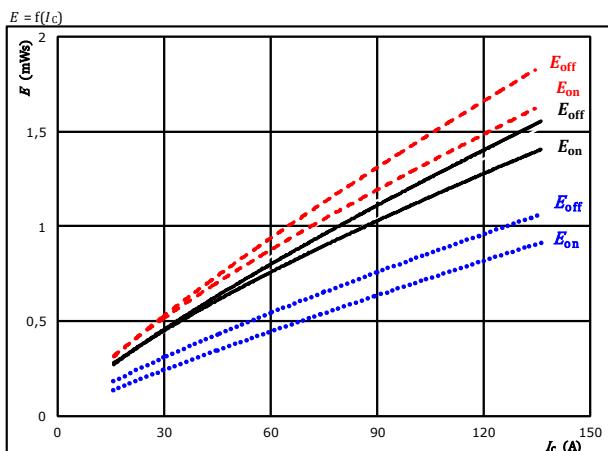


figure 2.

Typical switching energy losses as a function of gate resistor

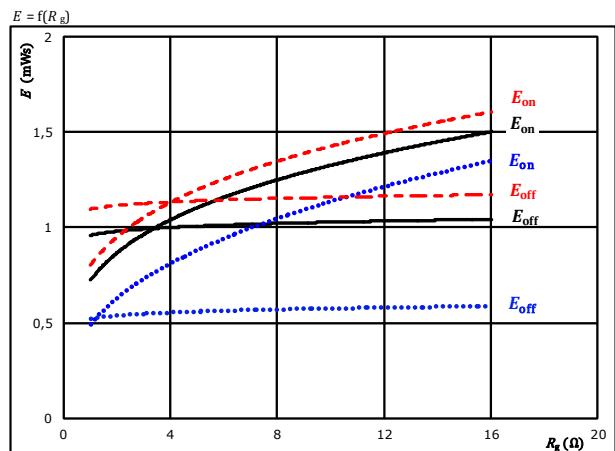


figure 3.

Typical reverse recovered energy loss as a function of collector current

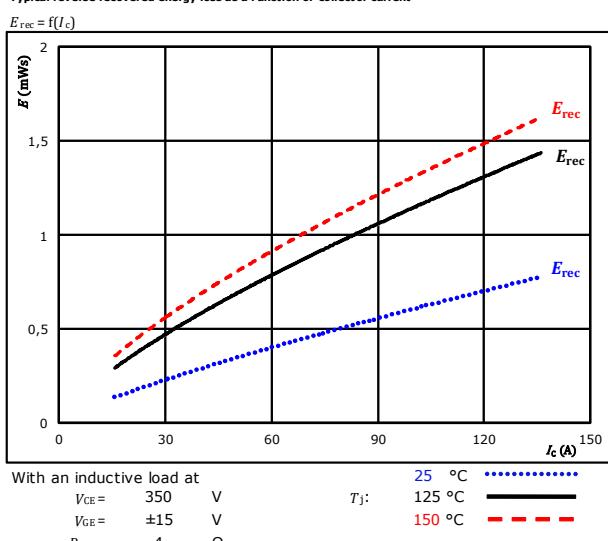
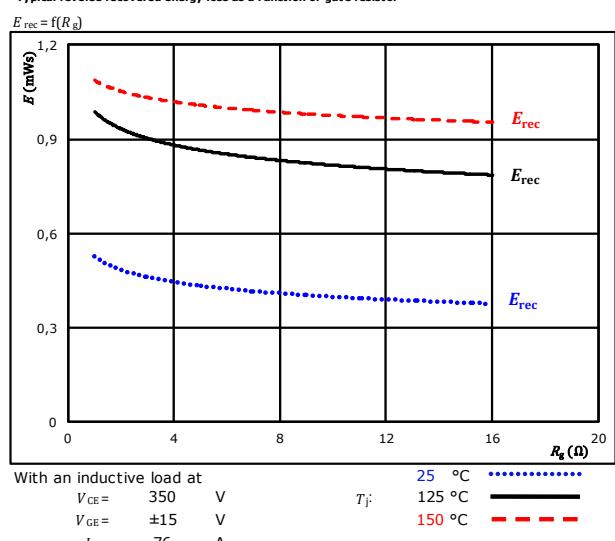


figure 4.

Typical reverse recovered energy loss as a function of gate resistor



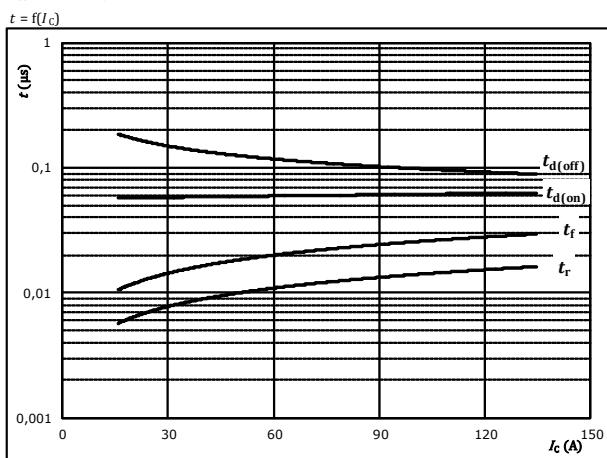


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## Low Boost Switching Characteristics

**figure 5.**

Typical switching times as a function of collector current

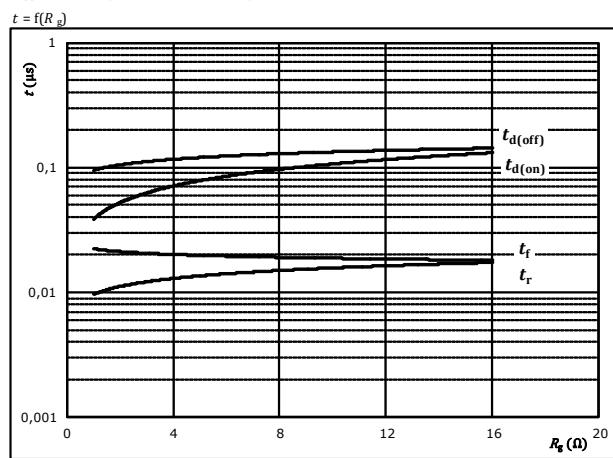


With an inductive load at

$T_j = 150^\circ\text{C}$   
 $V_{CE} = 350\text{ V}$   
 $V_{GE} = \pm 15\text{ V}$   
 $R_{gon} = 4\Omega$   
 $R_{goff} = 4\Omega$

**figure 6.**

Typical switching times as a function of gate resistor

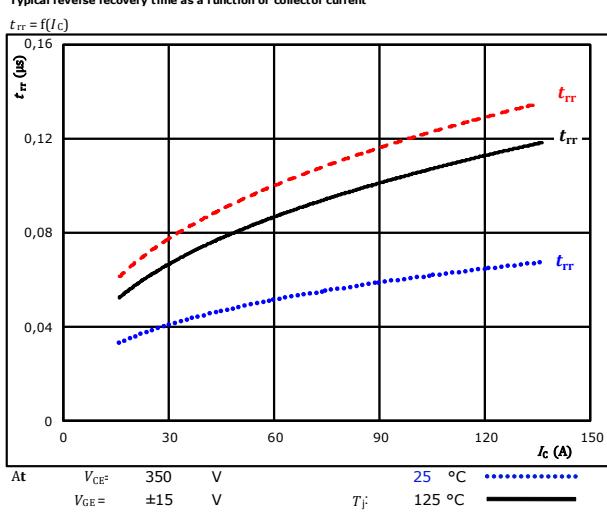


With an inductive load at

$T_j = 150^\circ\text{C}$   
 $V_{CE} = 350\text{ V}$   
 $V_{GE} = \pm 15\text{ V}$   
 $I_C = 76\text{ A}$

**figure 7.**

Typical reverse recovery time as a function of collector current

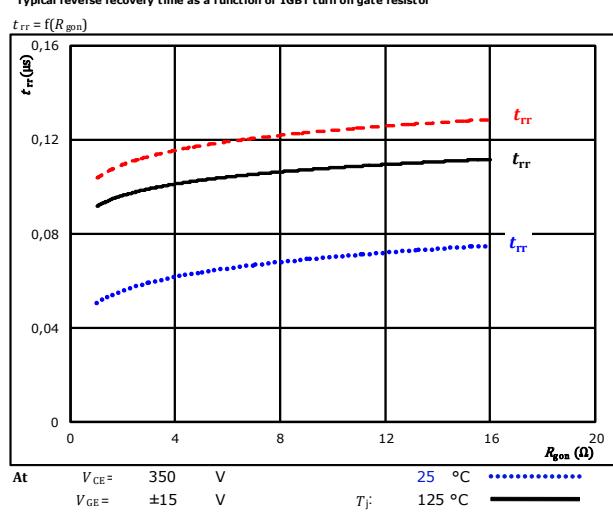


At

$V_{CE} = 350\text{ V}$	$V_{GE} = \pm 15\text{ V}$	$T_j = 25^\circ\text{C}$	$T_j = 125^\circ\text{C}$	$T_j = 150^\circ\text{C}$
$V_{GE} = \pm 15\text{ V}$	$V_{GE} = \pm 15\text{ V}$	$25^\circ\text{C}$	$125^\circ\text{C}$	$150^\circ\text{C}$
$R_{gon} = 4\Omega$	$R_{gon} = 4\Omega$	$25^\circ\text{C}$	$125^\circ\text{C}$	$150^\circ\text{C}$

**figure 8.**

Typical reverse recovery time as a function of IGBT turn on gate resistor

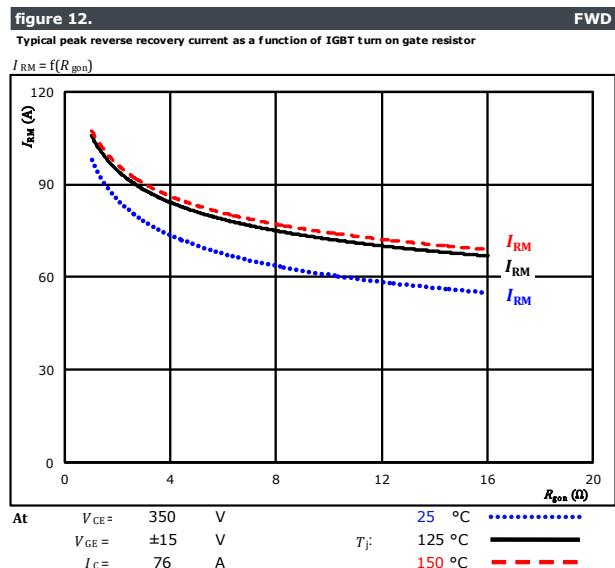
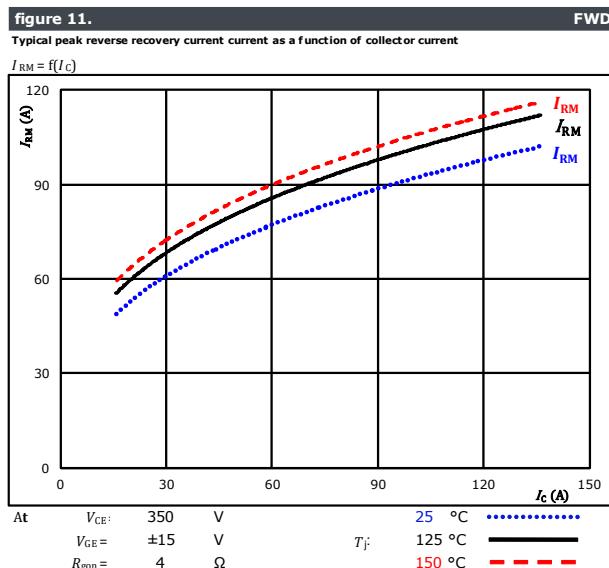
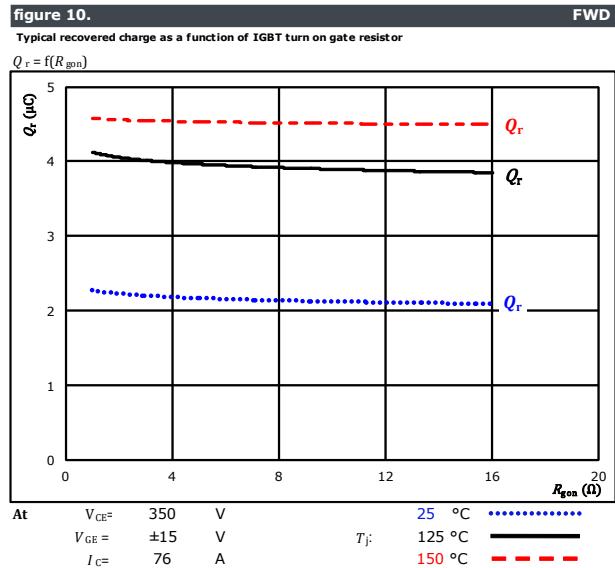
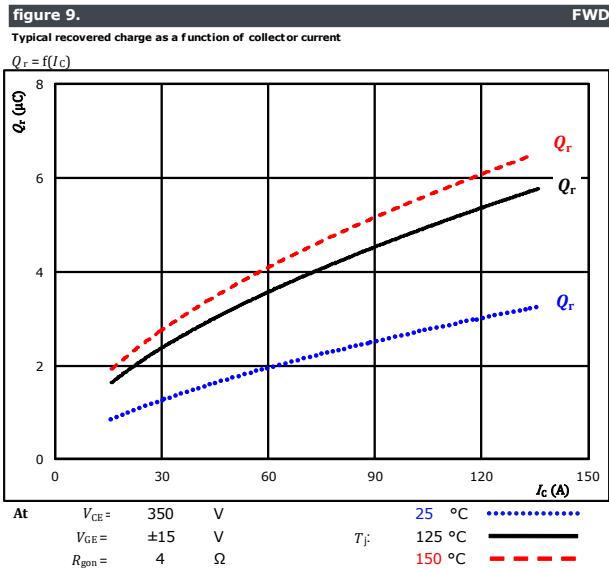


At

$V_{CE} = 350\text{ V}$	$V_{GE} = \pm 15\text{ V}$	$T_j = 25^\circ\text{C}$	$T_j = 125^\circ\text{C}$	$T_j = 150^\circ\text{C}$
$V_{GE} = \pm 15\text{ V}$	$V_{GE} = \pm 15\text{ V}$	$25^\circ\text{C}$	$125^\circ\text{C}$	$150^\circ\text{C}$
$I_C = 76\text{ A}$	$I_C = 76\text{ A}$	$25^\circ\text{C}$	$125^\circ\text{C}$	$150^\circ\text{C}$



## Low Boost Switching Characteristics





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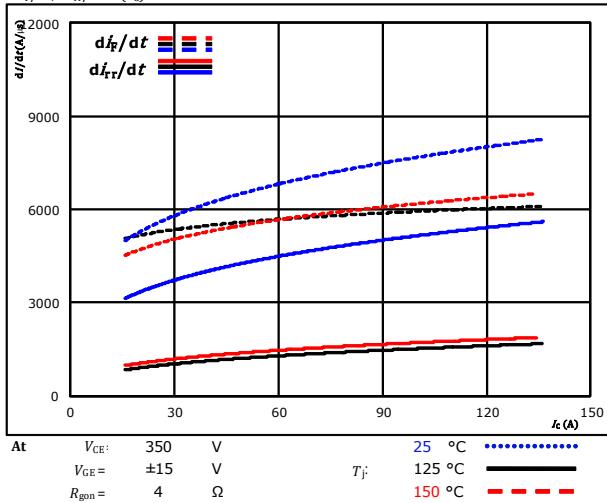
**10-FY07HVA075S502-L985F18  
10-PY07HVA075S502-L985F18Y**  
datasheet

## Low Boost Switching Characteristics

**figure 13.**

Typical rate of fall of forward and reverse recovery current as a function of collector current

$di_F/dt, di_{rr}/dt = f(I_C)$

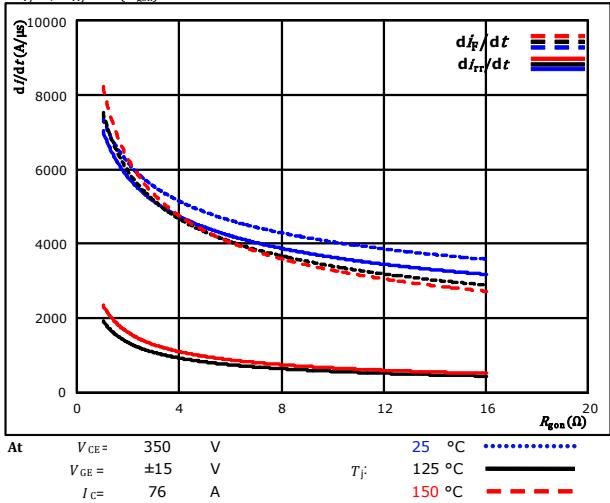


**FWD**

**figure 14.**

Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor

$di_F/dt, di_{rr}/dt = f(R_{gon})$



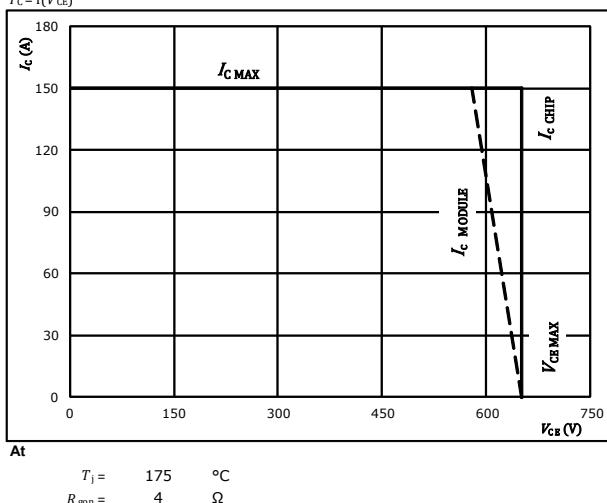
**FWD**

**figure 15.**

**IGBT**

Reverse bias safe operating area

$I_C = f(V_{CE})$





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datasheet

## Low Boost Switching Definitions

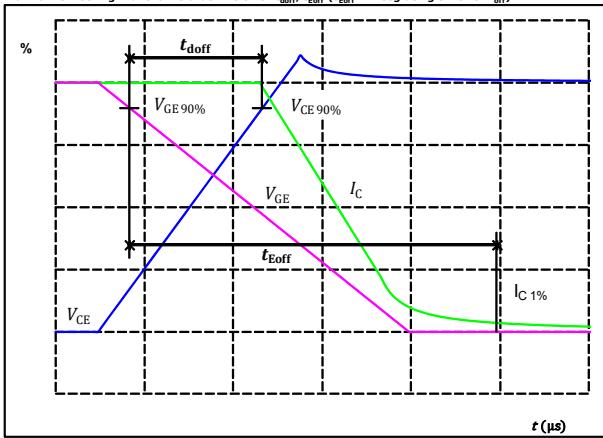
### General conditions

$T_j$	=	125 °C
$R_{gon}$	=	4 Ω
$R_{goff}$	=	4 Ω

figure 1.

IGBT

Turn-off Switching Waveforms & definition of  $t_{doff}$ ,  $t_{Eoff}$  ( $t_{Eoff}$  = integrating time for  $E_{off}$ )

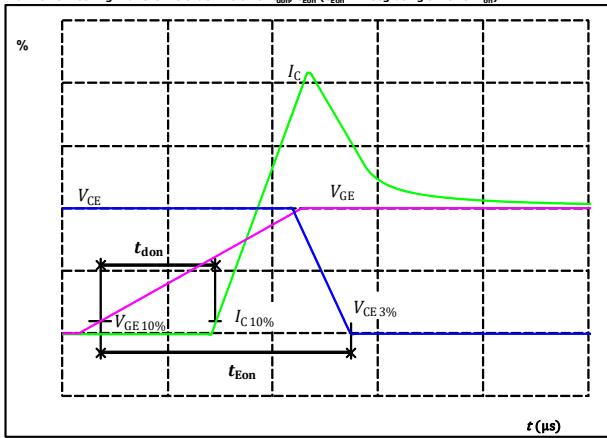


$V_{GE}(0\%) =$	-15	V
$V_{GE}(100\%) =$	15	V
$V_C(100\%) =$	350	V
$I_C(100\%) =$	76	A
$t_{doff} =$	106	ns

figure 2.

IGBT

Turn-on Switching Waveforms & definition of  $t_{don}$ ,  $t_{Eon}$  ( $t_{Eon}$  = integrating time for  $E_{on}$ )

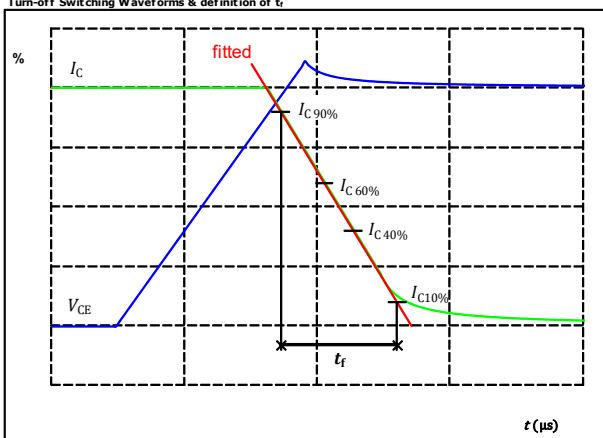


$V_{GE}(0\%) =$	-15	V
$V_{GE}(100\%) =$	15	V
$V_C(100\%) =$	350	V
$I_C(100\%) =$	76	A
$t_{don} =$	62	ns

figure 3.

IGBT

Turn-off Switching Waveforms & definition of  $t_f$

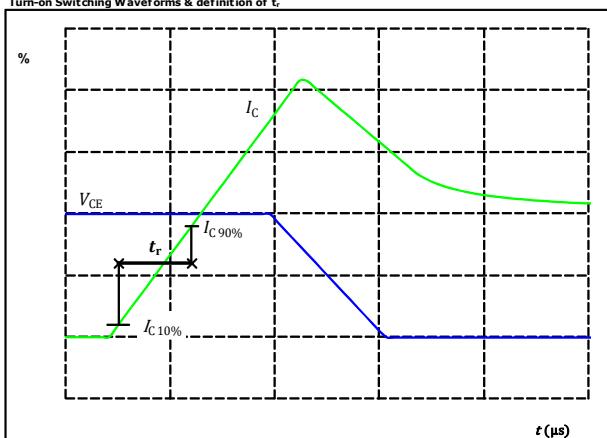


$V_C(100\%) =$	350	V
$I_C(100\%) =$	76	A
$t_f =$	17	ns

figure 4.

IGBT

Turn-on Switching Waveforms & definition of  $t_r$



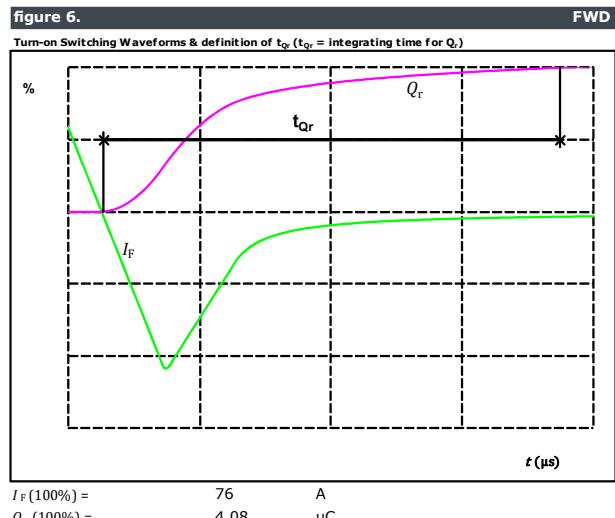
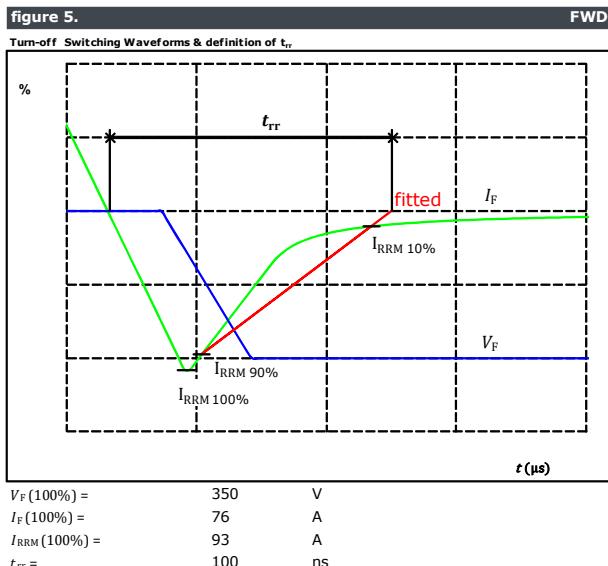
$V_C(100\%) =$	350	V
$I_C(100\%) =$	76	A
$t_r =$	10	ns



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datasheet

## Low Boost Switching Characteristics





## High Boost Switching Characteristics

figure 1.

Typical switching energy losses as a function of collector current

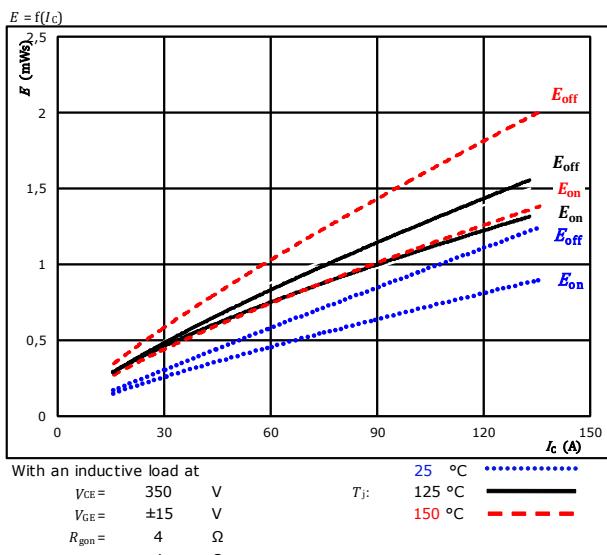


figure 2.

Typical switching energy losses as a function of gate resistor

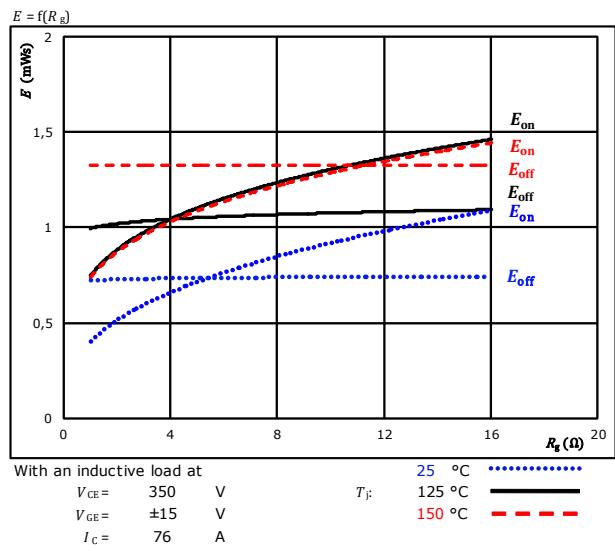


figure 3.

Typical reverse recovered energy loss as a function of collector current

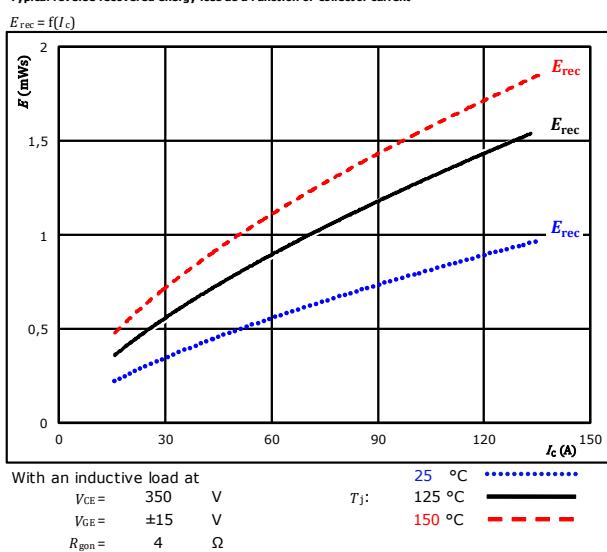
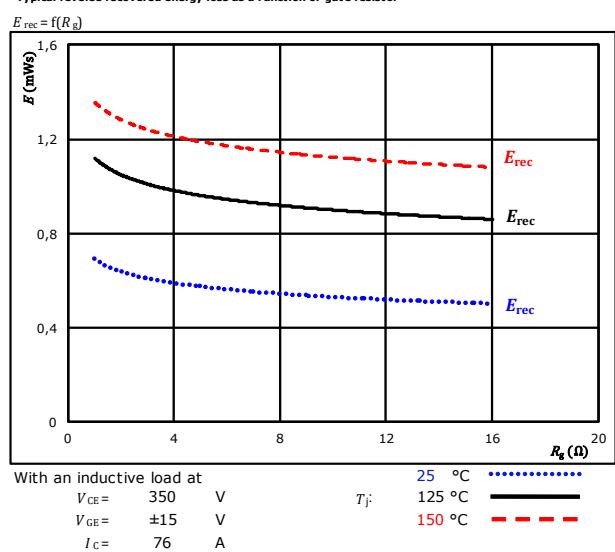


figure 4.

Typical reverse recovered energy loss as a function of gate resistor



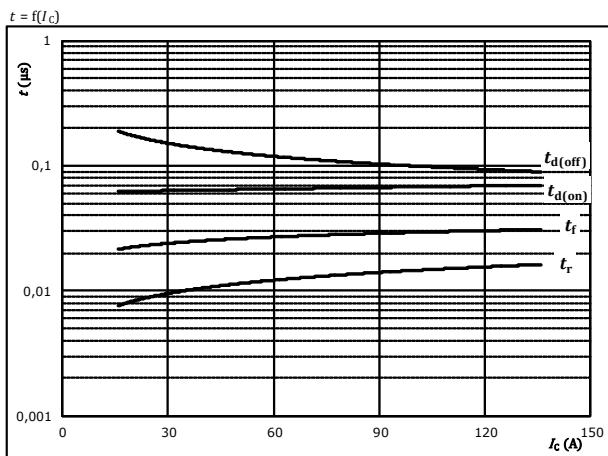


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## High Boost Switching Characteristics

**figure 5.** IGBT

Typical switching times as a function of collector current

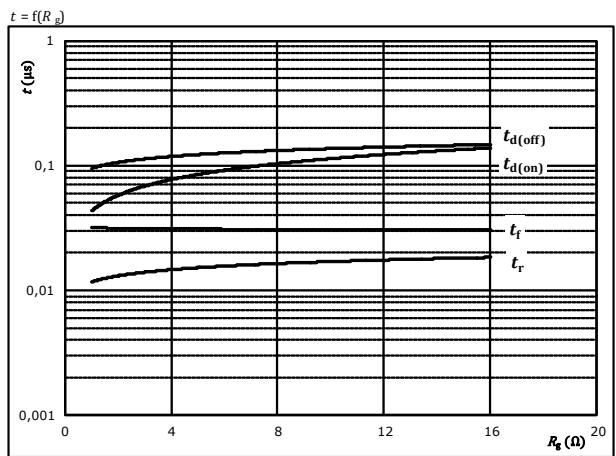


With an inductive load at

$T_J =$	150	°C
$V_{CE} =$	350	V
$V_{GE} =$	±15	V
$R_{gon} =$	4	Ω
$R_{goff} =$	4	Ω

**figure 6.** IGBT

Typical switching times as a function of gate resistor

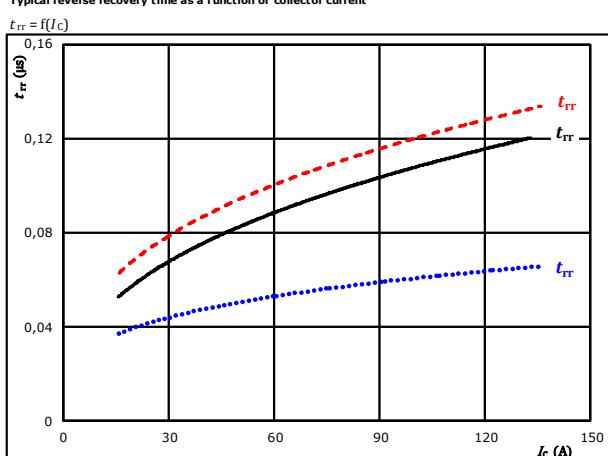


With an inductive load at

$T_J =$	150	°C
$V_{CE} =$	350	V
$V_{GE} =$	±15	V
$I_C =$	76	A

**figure 7.** FWD

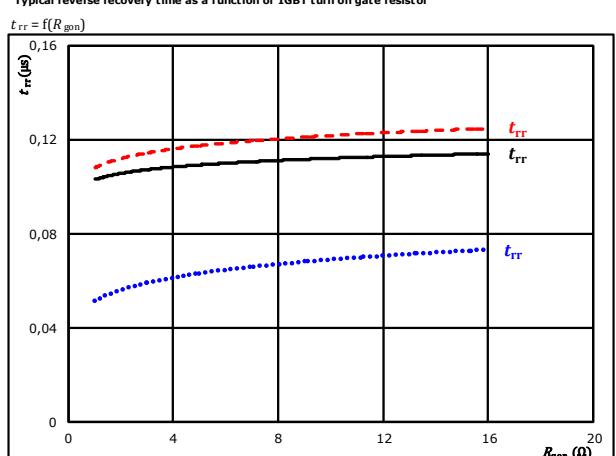
Typical reverse recovery time as a function of collector current



At	$V_{CE} =$	350	V	$25$ °C	.....
	$V_{GE} =$	±15	V	$T_J =$	125 °C —
	$R_{gon} =$	4	Ω		150 °C - - -

**figure 8.** FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor



At	$V_{CE} =$	350	V	$25$ °C	.....
	$V_{GE} =$	±15	V	$T_J =$	125 °C —
	$I_C =$	76	A		150 °C - - -



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datasheet

## High Boost Switching Characteristics

figure 9.

Typical recovered charge as a function of collector current

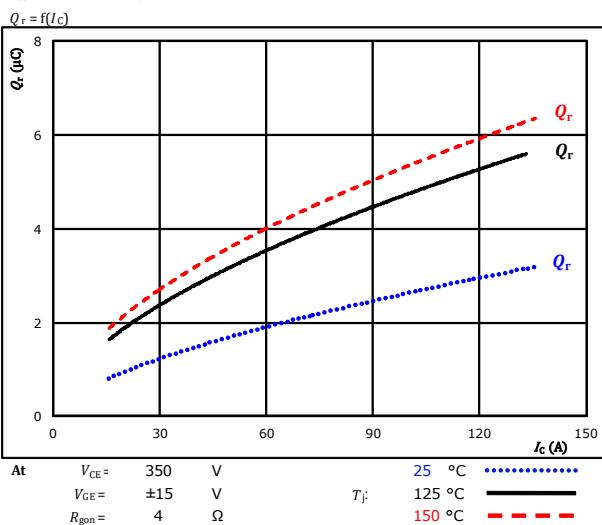


figure 10.

Typical recovered charge as a function of IGBT turn on gate resistor

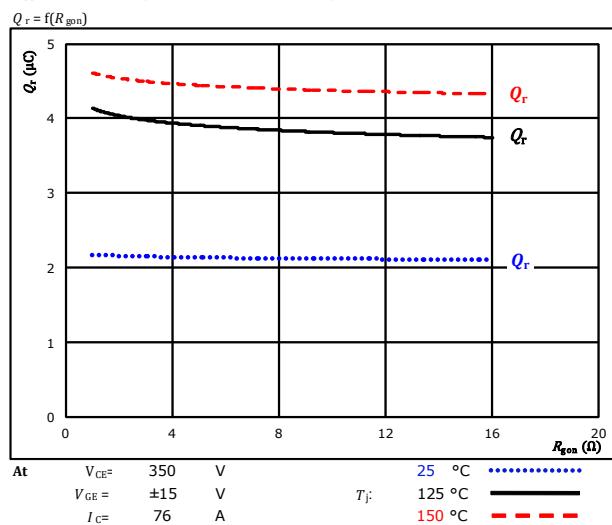


figure 11.

Typical peak reverse recovery current as a function of collector current

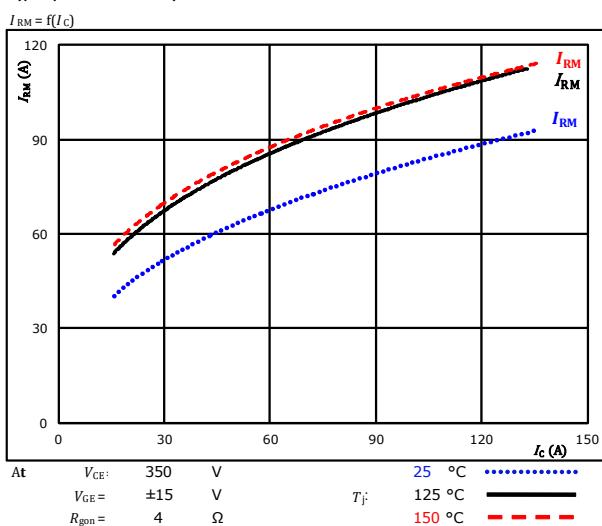
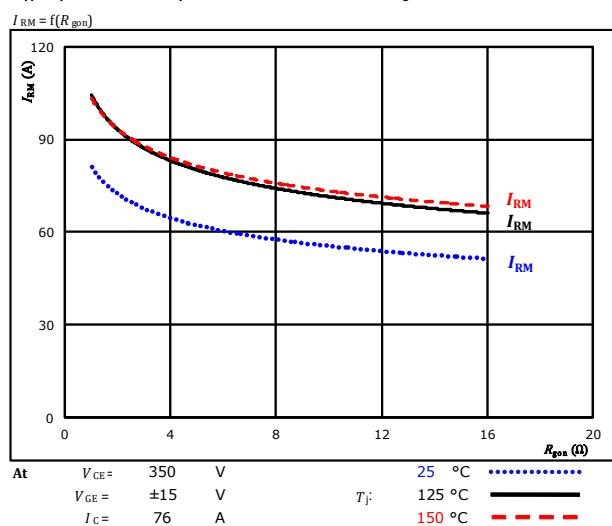


figure 12.

Typical peak reverse recovery current as a function of IGBT turn on gate resistor





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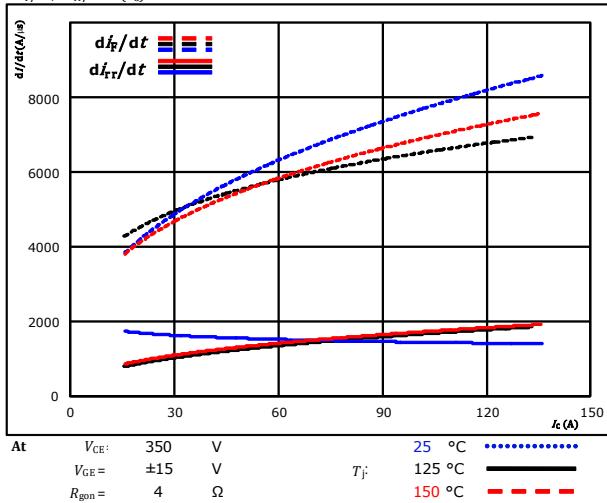
**10-FY07HVA075S502-L985F18  
10-PY07HVA075S502-L985F18Y**  
datasheet

## High Boost Switching Characteristics

**figure 13.**

Typical rate of fall of forward and reverse recovery current as a function of collector current

$di_F/dt, di_{rr}/dt = f(I_C)$

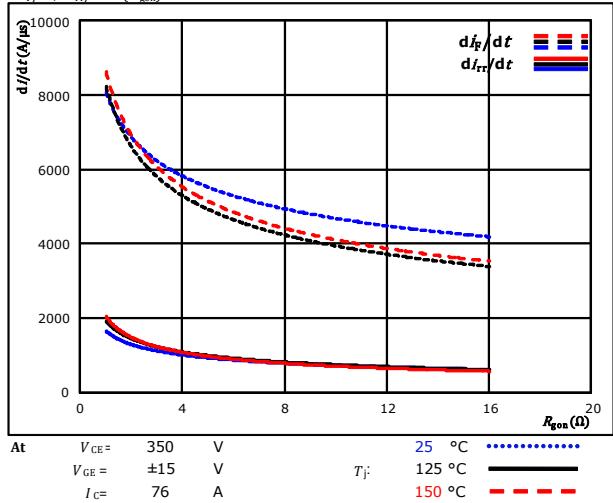


**FWD**

**figure 14.**

Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor

$di_F/dt, di_{rr}/dt = f(R_{gon})$



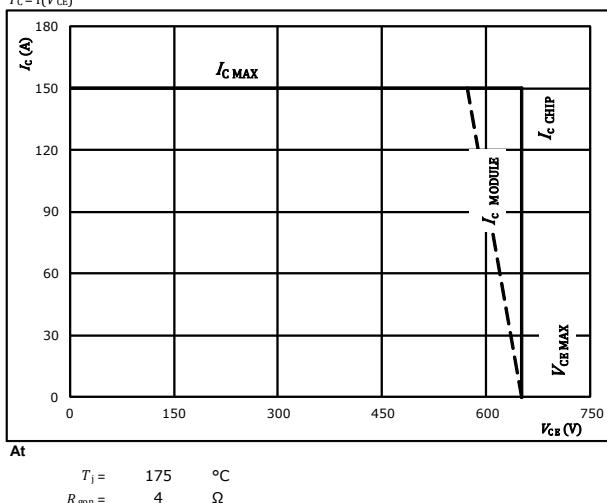
**FWD**

**figure 15.**

**IGBT**

Reverse bias safe operating area

$I_C = f(V_{CE})$





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10-PY07HVA075S502-L985F18Y**  
datasheet

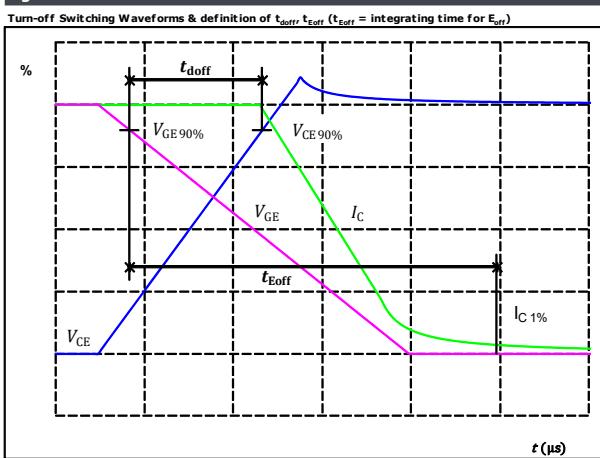
## High Boost Switching Definitions

### General conditions

$T_j$	=	125 °C
$R_{gon}$	=	4 Ω
$R_{goff}$	=	4 Ω

figure 1.

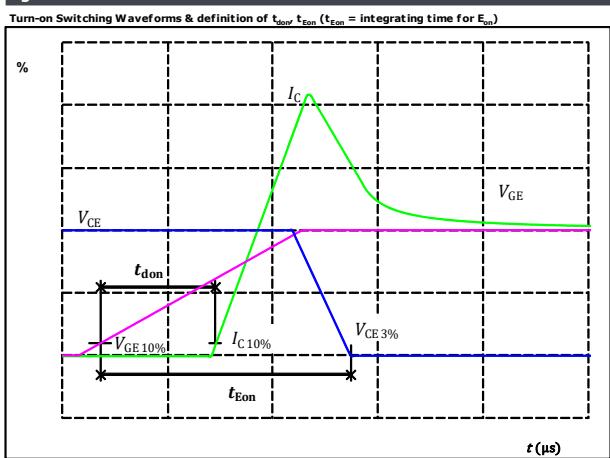
IGBT



$V_{GE\ (0\%)} =$	-15	V
$V_{GE\ (100\%)} =$	15	V
$V_C\ (100\%) =$	350	V
$I_C\ (100\%) =$	76	A
$t_{doff} =$	105	ns

figure 2.

IGBT

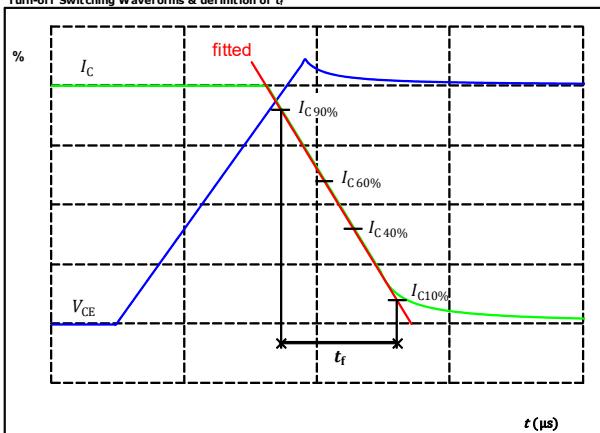


$V_{GE\ (0\%)} =$	-15	V
$V_{GE\ (100\%)} =$	15	V
$V_C\ (100\%) =$	350	V
$I_C\ (100\%) =$	76	A
$t_{don} =$	64	ns

figure 3.

IGBT

Turn-off Switching Waveforms & definition of  $t_f$

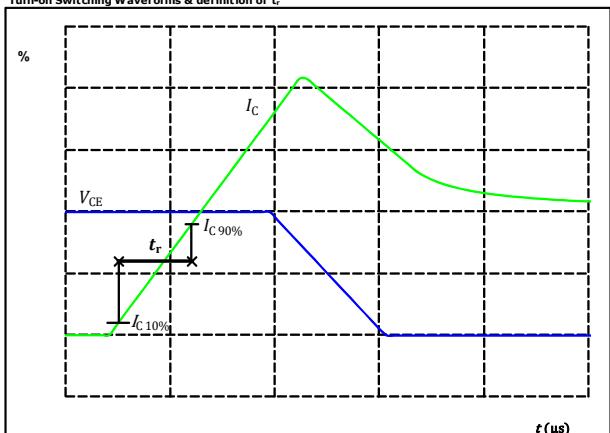


$V_C\ (100\%) =$	350	V
$I_C\ (100\%) =$	76	A
$t_f =$	21	ns

figure 4.

IGBT

Turn-on Switching Waveforms & definition of  $t_r$



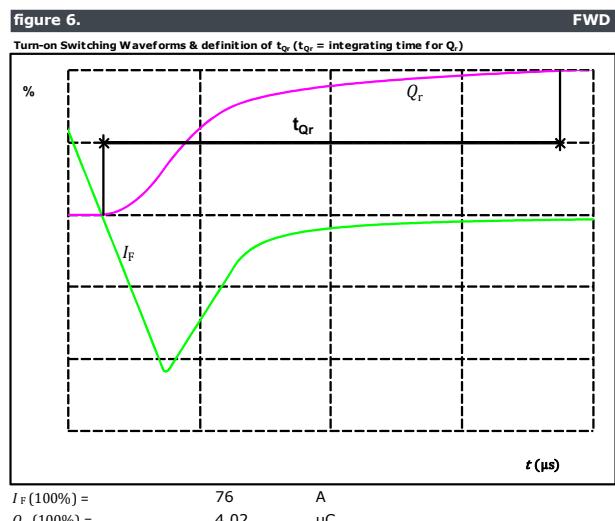
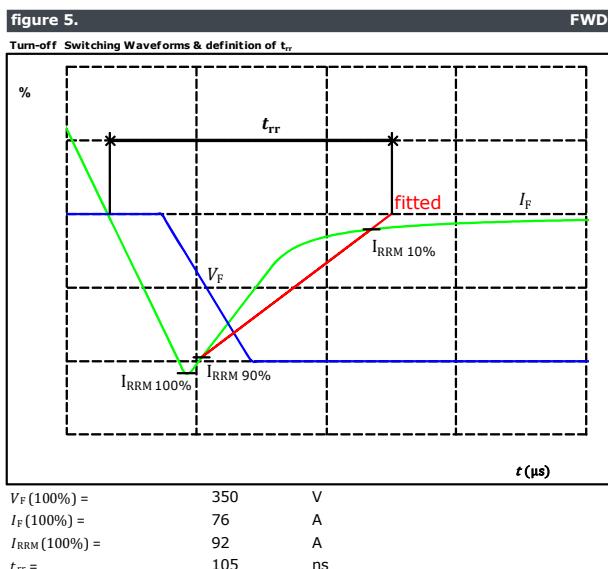
$V_C\ (100\%) =$	350	V
$I_C\ (100\%) =$	76	A
$t_r =$	11	ns



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10-FY07HVA075S502-L985F18  
10-PY07HVA075S502-L985F18Y  
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## High Boost Switching Characteristics

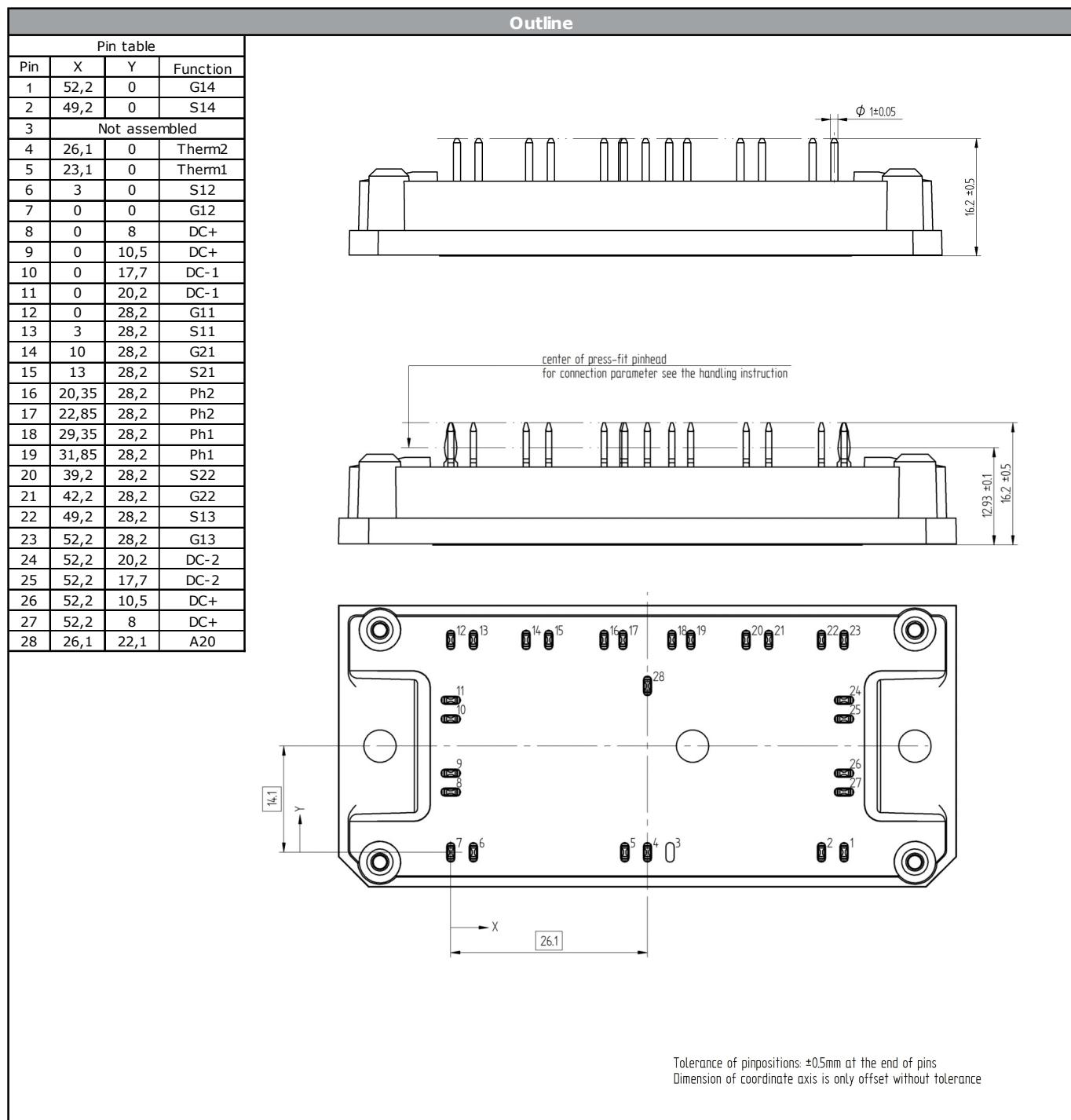




**10-FY07HVA075S502-L985F18**  
**10-PY07HVA075S502-L985F18Y**  
datasheet

Vincotech

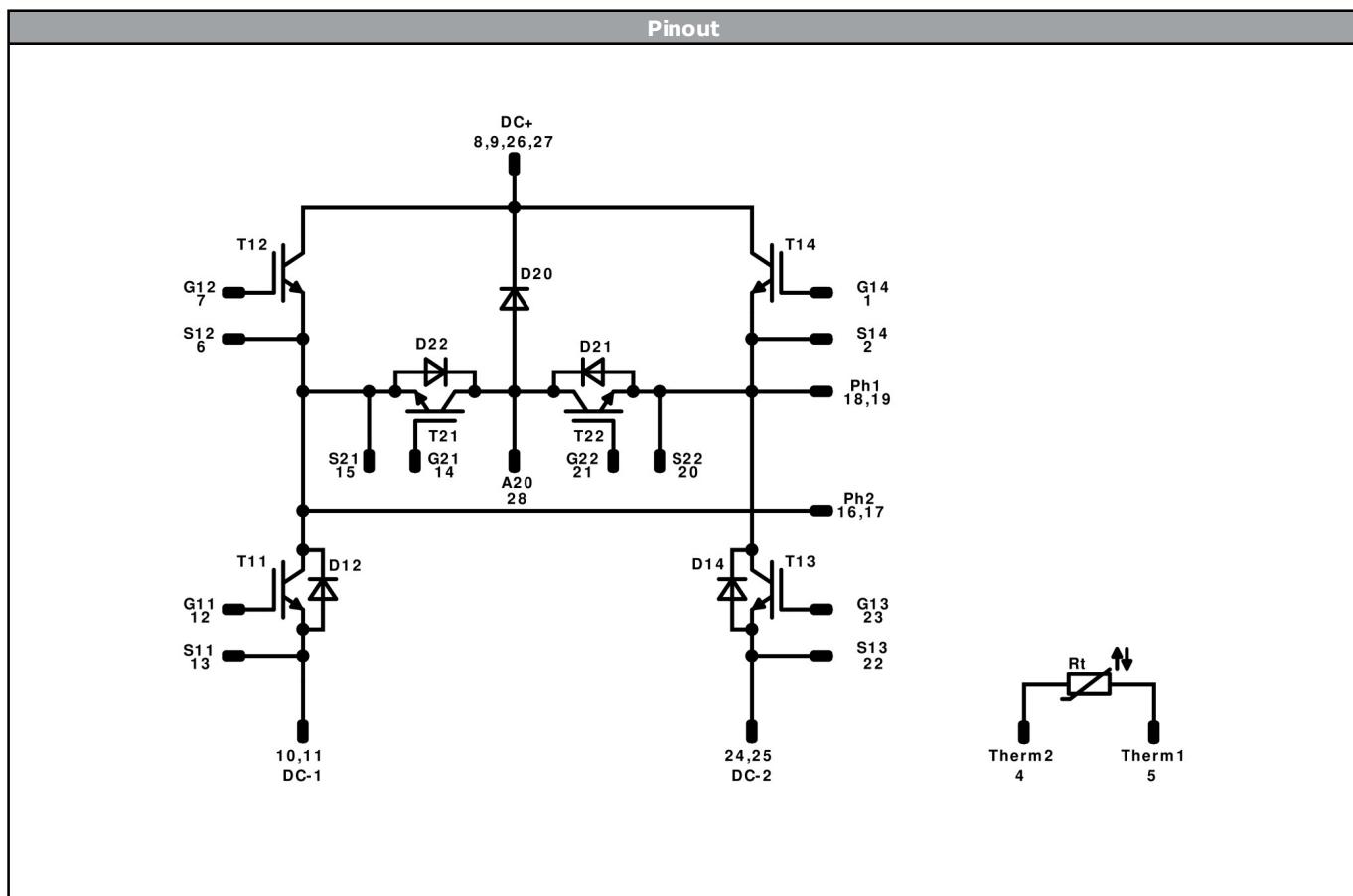
Ordering Code & Marking							
Version				Ordering Code			
without thermal paste with solder pins				10-FY07HVA075S502-L985F18			
without thermal paste with pressfit-pins				10-PY07HVA075S502-L985F18Y			
NN-NNNNNNNNNNNNNN TTTTTTVV WWYY UL VIN LLLL SSSS			Text	Name	Date code	UL & VIN	Lot
			Datamatrix	NN-NNNNNNNNNNNNN-TTTTTVV	WWYY	UL VIN	LLLL
				Type&Ver	Lot number	Serial	Date code
				TTTTTTVV	LLLLL	SSSS	WWYY





**10-FY07HVA075S502-L985F18**  
**10-PY07HVA075S502-L985F18Y**  
datasheet

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**Identification**

ID	Component	Voltage	Current	Function	Comment
T11, T13	IGBT	650 V	75 A	Low Buck Switch	
T12, T14	IGBT	650 V	75 A	High Buck Switch	
D21, D22	FWD	650 V	50 A	Buck Diode	
T21, T22	IGBT	650 V	75 A	Boost Switch	
D12, D14	FWD	650 V	50 A	Low Boost Diode	
D20	FWD	650 V	50 A	High Boost Diode	
Rt	NTC			Thermistor	



**10-FY07HVA075S502-L985F18**  
**10-PY07HVA075S502-L985F18Y**  
datasheet

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<b>Packaging instruction</b>			
Standard packaging quantity (SPQ) 100	>SPQ	Standard	<SPQ Sample

<b>Handling instruction</b>			
Handling instructions for flow 1 packages see vincotech.com website.			

<b>Package data</b>			
Package data for flow 1 packages see vincotech.com website.			

<b>UL recognition and file number</b>			
This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website.			

<b>Document No.:</b>	<b>Date:</b>	<b>Modification:</b>	<b>Pages</b>
10-PY07HVA075S502-L985F18Y-D4-14	12 Mar. 2019	Correction of $I_c/I_f$ values	2
10-xY07HVA075S502-L985F18x-D5-14	29 May. 2020	Solder pin version added	All

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.